



# THE DATASHEET OF EVAL-ADM1276EBZ



### FEATURES

- Controls supply voltages from 2 V to 20 V
- 370 ns response time to short circuit
- Resistor-programmable 5 mV to 25 mV current limit
- ±1% accurate, 12-bit ADC for current,  $V_{IN}/V_{OUT}$  readback
- Charge pumped gate drive for multiple external N-channel FETs
- High gate drive voltage to ensure lowest  $R_{DS(on)}$
- Foldback for tighter FET SOA protection
- Automatic retry or latch-off on current fault
- Programmable current-limit timer for SOA
- Programmable, multifunction GPO
- Power-good status output
- Analog UV and OV protection
- ENABLE pin
- Reports power and energy consumption over time
- Peak detect registers for current and voltage
- PMBus fast mode compliant interface
- 20-lead LFCSP

### APPLICATIONS

- Power monitoring and control/power budgeting
- Central office equipment
- Telecommunication and data communication equipment
- PCs/servers

### GENERAL DESCRIPTION

The [ADM1276](#) is a hot swap controller that allows a circuit board to be removed from or inserted into a live backplane. It also features current and voltage readback via an integrated 12-bit analog-to-digital converter (ADC), accessed using a PMBus™ interface.

The load current is measured using an internal current sense amplifier that measures the voltage across a sense resistor in the power path via the SENSE+ and SENSE– pins. A default limit of 20 mV is set, but this limit can be adjusted, if required, using a resistor divider network from the internal reference voltage to the ISET pin.

The [ADM1276](#) limits the current through the sense resistor by controlling the gate voltage of an external N-channel FET in the power path, via the GATE pin. The sense voltage—and, therefore, the load current—is maintained below the preset maximum. The [ADM1276](#) protects the external FET by limiting the time that the FET remains on while the current is at its maximum value. This current-limit time is set by the choice of capacitor connected to the TIMER pin. In addition, a foldback resistor network can be used to actively lower the current limit as the voltage across the FET is increased. This helps to maintain constant power in the

### FUNCTIONAL BLOCK DIAGRAM

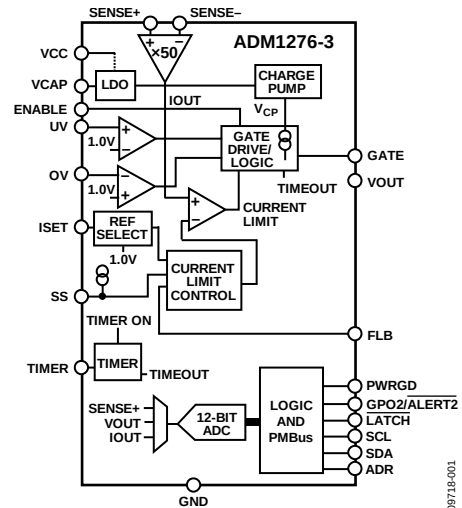


Figure 1.

FET and allows the safe operating area (SOA) to be adhered to in an effective manner.

In case of a short-circuit event, a fast internal overcurrent detector responds within 370 ns and signals the gate to shut down. A 1500 mA pull-down device ensures a fast FET response. The [ADM1276](#) features overvoltage (OV) and undervoltage (UV) protection, programmed using external resistor dividers on the UV and OV pins. A PWRGD signal can be used to detect when the output supply is valid, using the FLB pin to monitor the output. A GPO pin can be configured as an output signal that can be asserted when a programmed current or voltage level is reached.

The 12-bit ADC can measure the current in the sense resistor, as well as the supply voltage on the SENSE+ pin or the output voltage. A PMBus interface allows a controller to read current and voltage data from the ADC. Measurements can be initiated by a PMBus command. Alternatively, the ADC can run continuously, and the user can read the latest conversion data whenever required. As many as four unique PMBus addresses can be selected, depending on the way that the ADR pin is connected.

The [ADM1276](#) is available in a 20-lead LFCSP with a LATCH pin that can be configured for automatic retry or latch-off when an overcurrent fault occurs.

Rev. C

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## REVISION HISTORY

### 11/13—Rev. B to Rev. C

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### 4/13—Rev. A to Rev. B

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### 7/11—Rev. 0 to Rev. A

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### 3/11—Revision 0: Initial Version

## SPECIFICATIONS

$V_{CC} = 2.95\text{ V to }20\text{ V}$ ,  $V_{CC} \geq V_{SENSE+}$ ,  $V_{SENSE+} = 2\text{ V to }20\text{ V}$ ,  $V_{SENSE} = (V_{SENSE+} - V_{SENSE-}) = 0\text{ V}$ ,  $T_A = -40^{\circ}\text{C to }+85^{\circ}\text{C}$ , unless otherwise noted.

Table 1.

| Parameter                       | Symbol                   | Min  | Typ  | Max  | Unit | Test Conditions/Comments                                                                                                                                                                                                 |
|---------------------------------|--------------------------|------|------|------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| POWER SUPPLY                    |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Operating Voltage Range         | V <sub>CC</sub>          | 2.95 |      | 20   | V    | V <sub>CC</sub> rising                                                                                                                                                                                                   |
| Undervoltage Lockout            |                          | 2.4  |      | 2.7  | V    |                                                                                                                                                                                                                          |
| Undervoltage Hysteresis         |                          |      | 90   | 120  | mV   | GATE on and power monitor running                                                                                                                                                                                        |
| Quiescent Current               | I <sub>CC</sub>          |      |      | 5    | mA   |                                                                                                                                                                                                                          |
| UV PIN                          |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Input Current                   | I <sub>UV</sub>          |      |      | 100  | nA   | UV ≤ 3.6 V                                                                                                                                                                                                               |
| UV Threshold                    | UV <sub>TH</sub>         | 0.97 | 1.0  | 1.03 | V    | UV falling                                                                                                                                                                                                               |
| UV Threshold Hysteresis         | UV <sub>HYST</sub>       | 40   | 50   | 60   | mV   | 50 mV overdrive<br>UV low to GATE pull-down active                                                                                                                                                                       |
| UV Glitch Filter                | UV <sub>GF</sub>         | 2    |      | 7    | μs   |                                                                                                                                                                                                                          |
| UV Propagation Delay            | UV <sub>PD</sub>         |      | 5    | 8    | μs   |                                                                                                                                                                                                                          |
| OV PIN                          |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Input Current                   | I <sub>OV</sub>          |      |      | 100  | nA   | OV ≤ 3.6 V                                                                                                                                                                                                               |
| OV Threshold                    | OV <sub>TH</sub>         | 0.97 | 1.0  | 1.03 | V    | OV rising                                                                                                                                                                                                                |
| OV Threshold Hysteresis         | OV <sub>HYST</sub>       | 50   | 60   | 70   | mV   | 50 mV overdrive<br>OV high to GATE pull-down active                                                                                                                                                                      |
| OV Glitch Filter                | OV <sub>GF</sub>         | 0.5  |      | 1.5  | μs   |                                                                                                                                                                                                                          |
| OV Propagation Delay            | OV <sub>PD</sub>         |      | 1.0  | 2    | μs   |                                                                                                                                                                                                                          |
| SENSE+ AND SENSE− PINS          |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Input Current                   | I <sub>SENSEX</sub>      |      |      | 150  | μA   | Per individual pin; SENSE+, SENSE− = 20 V                                                                                                                                                                                |
| Input Imbalance                 | I <sub>ΔSENSE</sub>      |      |      | 5    | μA   | I <sub>ΔSENSE</sub> = (I <sub>SENSE+</sub> ) − (I <sub>SENSE−</sub> )                                                                                                                                                    |
| VCAP PIN                        |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Internally Regulated Voltage    | V <sub>VCAP</sub>        | 2.66 | 2.7  | 2.74 | V    | 0 μA ≤ I <sub>VCAP</sub> ≤ 100 μA; C <sub>VCAP</sub> = 1 μF                                                                                                                                                              |
| ISET PIN                        |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Reference Select Threshold      | V <sub>ISETRSTH</sub>    | 1.35 | 1.5  | 1.65 | V    | If V <sub>ISET</sub> > V <sub>ISETRSTH</sub> , an internal 1 V reference (V <sub>CLREF</sub> ) is used<br>Accuracies included in total sense voltage accuracies<br>Accuracies included in total sense voltage accuracies |
| Internal Reference              | V <sub>CLREF</sub>       |      | 1    |      | V    |                                                                                                                                                                                                                          |
| Gain of Current Sense Amplifier | AV <sub>CSAMP</sub>      |      | 50   |      | V/V  |                                                                                                                                                                                                                          |
| Input Current                   | I <sub>ISET</sub>        |      |      | 100  | nA   | V <sub>ISET</sub> ≤ V <sub>VCAP</sub>                                                                                                                                                                                    |
| GATE PIN                        |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Gate Drive Voltage              | ΔV <sub>GATE</sub>       |      |      |      |      | Maximum voltage on the gate is always clamped to ≤31 V<br>ΔV <sub>GATE</sub> = V <sub>GATE</sub> − V <sub>SENSE+</sub>                                                                                                   |
|                                 |                          | 10   | 12   | 14   | V    | 15 V ≥ V <sub>CC</sub> ≥ 8 V; I <sub>GATE</sub> ≤ 5 μA                                                                                                                                                                   |
|                                 |                          | 4.5  |      | 13   | V    | 20 V ≥ V <sub>CC</sub> ≥ 15 V; I <sub>GATE</sub> ≤ 5 μA                                                                                                                                                                  |
|                                 |                          | 8    |      | 10   | V    | V <sub>SENSE+</sub> = V <sub>CC</sub> = 5 V; I <sub>GATE</sub> ≤ 5 μA                                                                                                                                                    |
|                                 |                          | 4.5  |      | 6    | V    | V <sub>SENSE+</sub> = V <sub>CC</sub> = 2.95 V; I <sub>GATE</sub> ≤ 1 μA                                                                                                                                                 |
| Gate Pull-Up Current            | I <sub>GATEUP</sub>      | −20  |      | −30  | μA   | V <sub>GATE</sub> = 0 V                                                                                                                                                                                                  |
| Gate Pull-Down Current          | I <sub>GATEDN</sub>      |      |      |      |      |                                                                                                                                                                                                                          |
| Regulation                      | I <sub>GATEDN_REG</sub>  | 45   | 60   | 75   | μA   | V <sub>GATE</sub> ≥ 2 V; V <sub>ISET</sub> = 1.0 V; (SENSE+) − (SENSE−) = 30 mV                                                                                                                                          |
| Slow                            | I <sub>GATEDN_SLOW</sub> | 5    | 10   | 15   | mA   | V <sub>GATE</sub> ≥ 2 V                                                                                                                                                                                                  |
| Fast                            | I <sub>GATEDN_FAST</sub> | 750  | 1500 | 2000 | mA   | V <sub>GATE</sub> ≥ 12 V; V <sub>CC</sub> ≥ 12 V                                                                                                                                                                         |
| Gate Holdoff Resistance         |                          |      | 20   |      | Ω    | V <sub>CC</sub> = 0 V                                                                                                                                                                                                    |
| HOT SWAP SENSE VOLTAGE          |                          |      |      |      |      |                                                                                                                                                                                                                          |
| Hot Swap Sense Voltage          | V <sub>SENSECL</sub>     | 19.6 | 20   | 20.4 | mV   | V <sub>ISET</sub> > 1.65 V; V <sub>FLB</sub> > 1.12 V; V <sub>GATE</sub> = (SENSE+) + 3 V; I <sub>GATE</sub> = 0 μA; V <sub>SS</sub> ≥ 2 V                                                                               |
| Current Limit                   |                          |      |      |      |      | V <sub>GATE</sub> = (SENSE+) + 3 V; I <sub>GATE</sub> = 0 μA; V <sub>SS</sub> ≥ 2 V                                                                                                                                      |
| Foldback Inactive               |                          | 24.6 | 25   | 25.4 | mV   | V <sub>ISET</sub> = 1.25 V; V <sub>FLB</sub> > 1.395 V                                                                                                                                                                   |
|                                 |                          | 19.6 | 20   | 20.4 | mV   | V <sub>ISET</sub> = 1.0 V; V <sub>FLB</sub> > 1.12 V                                                                                                                                                                     |
|                                 |                          | 9.6  | 10   | 10.4 | mV   | V <sub>ISET</sub> = 0.5 V; V <sub>FLB</sub> > 0.57 V                                                                                                                                                                     |
|                                 |                          | 4.6  | 5    | 5.4  | mV   | V <sub>ISET</sub> = 0.25 V; V <sub>FLB</sub> > 0.295 V                                                                                                                                                                   |

| Parameter                             | Symbol            | Min  | Typ  | Max  | Unit          | Test Conditions/Comments                                                                                                                                                   |
|---------------------------------------|-------------------|------|------|------|---------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Foldback Active                       |                   | 3.5  | 4    | 4.5  | mV            | $V_{FLB} = 0\text{ V}$ ; $V_{GATE} = (\text{SENSE+}) + 3\text{ V}$ ; $I_{GATE} = 0\text{ }\mu\text{A}$ ; $V_{SS} \geq 1\text{ V}$                                          |
|                                       |                   | 9.6  | 10   | 10.4 | mV            | $V_{ISET} > 1.0\text{ V}$ ; $V_{FLB} = 0.5\text{ V}$ ; $V_{GATE} = (\text{SENSE+}) + 3\text{ V}$ ; $I_{GATE} = 0\text{ }\mu\text{A}$ ; $V_{SS} \geq 1\text{ V}$            |
| Circuit Breaker Offset                | $V_{CBOS}$        | 0.6  | 0.88 | 1.12 | mV            | Circuit breaker trip voltage, $V_{CB} = V_{SENSECL} - V_{CBOS}$                                                                                                            |
| SEVERE OVERCURRENT                    |                   |      |      |      |               |                                                                                                                                                                            |
| Voltage Threshold                     | $V_{SENSEOC}$     | 40   |      | 50   | mV            | $V_{ISET} = 1.0\text{ V}$ ; $V_{FLB} > 1.1\text{ V}$ ; $V_{SS} \geq 2\text{ V}$                                                                                            |
|                                       |                   | 9.5  |      | 13.0 | mV            | $V_{ISET} = 0.25\text{ V}$ ; $V_{FLB} > 1.1\text{ V}$ ; $V_{SS} \geq 2\text{ V}$                                                                                           |
| Short Glitch Filter Duration          |                   | 90   |      | 200  | ns            | $V_{ISET} > 1.65\text{ V}$ ; $V_{SENSE}$ driven from 18 mV to 52 mV; selectable via PMBus                                                                                  |
| Long Glitch Filter Duration (Default) |                   | 530  |      | 900  | ns            | $V_{SENSE}$ driven from 18 mV to 52 mV                                                                                                                                     |
| Response Time                         |                   |      |      |      |               |                                                                                                                                                                            |
| With Short Glitch Filter              |                   | 180  |      | 370  | ns            | 2 mV overdrive maximum severe overcurrent threshold                                                                                                                        |
| With Long Glitch Filter               |                   | 645  |      | 1020 | ns            |                                                                                                                                                                            |
| SOFT START (SS PIN)                   |                   |      |      |      |               |                                                                                                                                                                            |
| SS Pull-Up Current                    | $I_{SS}$          | -12  | -10  | -8   | $\mu\text{A}$ | $V_{SS} = 0\text{ V}$                                                                                                                                                      |
| Default $V_{SENSECL}$ Limit           |                   | 0.5  | 1.25 | 1.8  | mV            | When $V_{SENSE}$ reaches this level, $I_{SS}$ is enabled, ramping $V_{SENSECL}$ ; $V_{SS} = 0\text{ V}$                                                                    |
| SS Pull-Down Current                  |                   |      | 100  |      | $\mu\text{A}$ | $V_{SS} = 1\text{ V}$                                                                                                                                                      |
| TIMER PIN                             |                   |      |      |      |               |                                                                                                                                                                            |
| Timer Pull-Up Current                 | $I_{TIMERUP}$     |      |      |      |               | Initial power-on reset; $V_{TIMER} = 0.5\text{ V}$<br>Overcurrent fault; $0.2\text{ V} \leq V_{TIMER} \leq 1\text{ V}$                                                     |
| Power-On Reset(POR)                   | $I_{TIMERUPPOR}$  | -2   | -3   | -4   | $\mu\text{A}$ |                                                                                                                                                                            |
| Overcurrent (OC) Fault                | $I_{TIMERUPFLT}$  | -57  | -60  | -63  | $\mu\text{A}$ |                                                                                                                                                                            |
| Timer Pull-Down Current               |                   |      |      |      |               | After fault when GATE is off; $V_{TIMER} = 0.5\text{ V}$<br>Holds TIMER at 0 V when inactive; $V_{TIMER} = 0.5\text{ V}$<br>Defines the limits of the autoretry duty cycle |
| Retry                                 | $I_{TIMERDNRT}$   | 1.7  | 2    | 2.3  | $\mu\text{A}$ |                                                                                                                                                                            |
| Hold                                  | $I_{TIMERDNHOLD}$ |      | 100  |      | $\mu\text{A}$ |                                                                                                                                                                            |
| Timer Retry/OC Fault Current Ratio    |                   |      | 3.33 | 3.8  | %             |                                                                                                                                                                            |
| Timer High Threshold                  | $V_{TIMERH}$      | 0.98 | 1.0  | 1.02 | V             |                                                                                                                                                                            |
| Timer Low Threshold                   | $V_{TIMERL}$      | 0.18 | 0.2  | 0.22 | V             |                                                                                                                                                                            |
| FOLDBACK (FLB PIN)                    |                   |      |      |      |               |                                                                                                                                                                            |
| FLB and PWRGD Threshold               | $V_{FLBTH}$       | 1.08 | 1.1  | 1.12 | V             | FLB rising; $V_{ISET} = 1.0\text{ V}$                                                                                                                                      |
| Input Current                         | $I_{FLB}$         |      |      | 100  | nA            | $V_{FLB} \leq 1.0\text{ V}$ ; $V_{ISET} = 1.25\text{ V}$                                                                                                                   |
|                                       |                   |      |      | 100  | nA            | $V_{CAP} \leq V_{FLB} \leq 20\text{ V}$                                                                                                                                    |
| Hysteresis Current                    |                   | 1.7  |      | 2.3  | $\mu\text{A}$ | Voltage drop across the internal 1.3 k $\Omega$ resistor<br>50 mV overdrive<br>Accuracies included in total sense voltage accuracies                                       |
| Internal Hysteresis Voltage           |                   | 1.9  |      | 3.1  | mV            |                                                                                                                                                                            |
| Power-Good Glitch Filter              | $PWRGD_{GF}$      | 0.3  | 0.7  | 1    | $\mu\text{s}$ |                                                                                                                                                                            |
| Minimum Foldback Clamp                |                   |      | 200  |      | mV            |                                                                                                                                                                            |
| VOUT PIN                              |                   |      |      |      |               |                                                                                                                                                                            |
| Input Current                         |                   |      |      | 20   | $\mu\text{A}$ | $V_{OUT} = 20\text{ V}$                                                                                                                                                    |
| LATCH PIN                             |                   |      |      |      |               |                                                                                                                                                                            |
| Output Low Voltage                    | $V_{OL\_LATCH}$   |      |      | 0.4  | V             | $I_{LATCH} = 1\text{ mA}$                                                                                                                                                  |
|                                       |                   |      |      | 1.5  | V             | $I_{LATCH} = 5\text{ mA}$                                                                                                                                                  |
| Leakage Current                       |                   |      |      | 100  | nA            | $V_{LATCH} \leq 2\text{ V}$ ; $\overline{LATCH}$ output high-Z                                                                                                             |
|                                       |                   |      |      | 1    | $\mu\text{A}$ | $V_{LATCH} = 20\text{ V}$ ; $\overline{LATCH}$ output high-Z                                                                                                               |
| ENABLE PIN                            |                   |      |      |      |               | No internal pull-up present on this pin                                                                                                                                    |
| Leakage Current                       |                   |      |      | 100  | nA            | $V_{GPO2} \leq 2\text{ V}$                                                                                                                                                 |
|                                       |                   |      |      | 1    | $\mu\text{A}$ | $V_{GPO2} = 20\text{ V}$                                                                                                                                                   |
| Input High Voltage                    | $V_{IH}$          | 1.1  |      |      | V             |                                                                                                                                                                            |
| Input Low Voltage                     | $V_{IL}$          |      |      | 0.8  | V             |                                                                                                                                                                            |

| Parameter                        | Symbol          | Min | Typ        | Max        | Unit          | Test Conditions/Comments                                                                                  |
|----------------------------------|-----------------|-----|------------|------------|---------------|-----------------------------------------------------------------------------------------------------------|
| GPO2/ALERT2 PIN                  |                 |     |            |            |               |                                                                                                           |
| Output Low Voltage               | $V_{OL\_GPO2}$  |     |            | 0.4        | V             | $I_{GPO2} = 1 \text{ mA}$                                                                                 |
|                                  |                 |     |            | 1.5        | V             | $I_{GPO2} = 5 \text{ mA}$                                                                                 |
| Leakage Current                  |                 |     |            | 100        | nA            | $V_{GPO2} \leq 2 \text{ V}$ ; GPO output high-Z                                                           |
|                                  |                 |     |            | 1          | $\mu\text{A}$ | $V_{GPO2} = 20 \text{ V}$ ; GPO output high-Z                                                             |
| PWRGD PIN                        |                 |     |            |            |               |                                                                                                           |
| Output Low Voltage               | $V_{OL\_PWRGD}$ |     |            | 0.4        | V             | $I_{PWRGD} = 1 \text{ mA}$                                                                                |
|                                  |                 |     |            | 1.5        | V             | $I_{PWRGD} = 5 \text{ mA}$                                                                                |
| VCC That Guarantees Valid Output |                 | 1   |            |            | V             | $I_{SINK} = 100 \mu\text{A}$ ; $V_{OL\_PWRGD} = 0.4 \text{ V}$                                            |
| Leakage Current                  |                 |     |            | 100        | nA            | $V_{PWRGD} \leq 2 \text{ V}$ ; PWRGD output high-Z                                                        |
|                                  |                 |     |            | 1          | $\mu\text{A}$ | $V_{PWRGD} = 20 \text{ V}$ ; PWRGD output high-Z                                                          |
| CURRENT AND VOLTAGE MONITORING   |                 |     |            |            |               |                                                                                                           |
| Current Sense Absolute Error     |                 |     |            |            |               | 25 mV input range; 128 sample averaging (unless otherwise noted)                                          |
|                                  |                 |     | $\pm 0.2$  | $\pm 0.7$  | %             | $V_{SENSE} = 20 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$ ; $T_A = 0^\circ\text{C}$ to $65^\circ\text{C}$ |
|                                  |                 |     | $\pm 0.08$ |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$ ; $T_A = 25^\circ\text{C}$                      |
|                                  |                 |     |            | $\pm 1.0$  | %             | $V_{SENSE} = 20 \text{ mV}$                                                                               |
|                                  |                 |     | $\pm 0.08$ |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; $T_A = 25^\circ\text{C}$                                                    |
|                                  |                 |     | $\pm 0.2$  |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; $T_A = 0^\circ\text{C}$ to $65^\circ\text{C}$                               |
|                                  |                 |     |            | $\pm 1.0$  | %             | $V_{SENSE} = 20 \text{ mV}$ ; 16 sample averaging                                                         |
|                                  |                 |     | $\pm 0.08$ |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; 16 sample averaging; $T_A = 25^\circ\text{C}$                               |
|                                  |                 |     | $\pm 0.2$  |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; 16 sample averaging; $T_A = 0^\circ\text{C}$ to $65^\circ\text{C}$          |
|                                  |                 |     |            | $\pm 2.8$  | %             | $V_{SENSE} = 20 \text{ mV}$ ; 1 sample averaging                                                          |
|                                  |                 |     | $\pm 0.09$ |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; 1 sample averaging; $T_A = 25^\circ\text{C}$                                |
|                                  |                 |     | $\pm 0.2$  |            | %             | $V_{SENSE} = 20 \text{ mV}$ ; 1 sample averaging; $T_A = 0^\circ\text{C}$ to $65^\circ\text{C}$           |
|                                  |                 |     |            | $\pm 0.7$  | %             | $V_{SENSE} = 25 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                 |
|                                  |                 |     | $\pm 0.04$ |            | %             | $V_{SENSE} = 25 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$ ; $T_A = 25^\circ\text{C}$                      |
|                                  |                 |     | $\pm 0.15$ |            | %             | $V_{SENSE} = 25 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$ ; $T_A = 0^\circ\text{C}$ to $65^\circ\text{C}$ |
|                                  |                 |     |            | $\pm 0.75$ | %             | $V_{SENSE} = 20 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                 |
|                                  |                 |     |            | $\pm 0.8$  | %             | $V_{SENSE} = 15 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                 |
|                                  |                 |     |            | $\pm 1.1$  | %             | $V_{SENSE} = 10 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                 |
|                                  |                 |     |            | $\pm 2.0$  | %             | $V_{SENSE} = 5 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                  |
|                                  |                 |     |            | $\pm 4.3$  | %             | $V_{SENSE} = 2.5 \text{ mV}$ ; $V_{SENSE+} = 12 \text{ V}$                                                |
| SENSE+/VOUT Absolute Error       |                 |     |            | $\pm 1.0$  | %             | Low input range; input voltage $\geq 3 \text{ V}$                                                         |
|                                  |                 |     |            | $\pm 1.0$  | %             | High input range; input voltage $\geq 10 \text{ V}$                                                       |
| ADC Conversion Time              |                 |     |            |            |               | Includes time for power multiplication                                                                    |
|                                  |                 |     | 237        | 280        | $\mu\text{s}$ | 1 sample of VIN and IOUT; from command received to valid data in register                                 |
|                                  |                 |     | 360        | 426        | $\mu\text{s}$ | 1 sample of VIN, VOUT, and IOUT; from command received to valid data in register                          |
|                                  |                 |     | 3753       | 4233       | $\mu\text{s}$ | 16 samples of VIN and IOUT averaged; from command received to valid data in register                      |
|                                  |                 |     | 5545       | 6570       | $\mu\text{s}$ | 16 samples of VIN, VOUT, and IOUT averaged; from command received to valid data in register               |
| Power Multiplication Time        |                 |     | 14         |            | $\mu\text{s}$ |                                                                                                           |
| ADR PIN                          |                 |     |            |            |               |                                                                                                           |
| Address Set to 00                |                 | 0   |            | 0.8        | V             | Connect to GND                                                                                            |
| Input Current for Address 00     |                 | -40 | -22        |            | $\mu\text{A}$ | $V_{ADR} = 0 \text{ V}$ to $0.8 \text{ V}$                                                                |
| Address Set to 01                |                 | 135 | 150        | 165        | k $\Omega$    | Resistor to GND                                                                                           |
| Address Set to 10                |                 | -1  |            | +1         | $\mu\text{A}$ | No connect state; maximum leakage current allowed                                                         |

| Parameter                                         | Symbol                | Min       | Typ | Max       | Unit               | Test Conditions/Comments                                                                                                  |
|---------------------------------------------------|-----------------------|-----------|-----|-----------|--------------------|---------------------------------------------------------------------------------------------------------------------------|
| Address Set to 11<br>Input Current for Address 11 |                       | 2         | 3   | 10        | V<br>$\mu\text{A}$ | Connect to VCAP<br>$V_{\text{ADR}} = 2.0\text{ V to VCAP}$ ; must not exceed the maximum allowable current draw from VCAP |
| SERIAL BUS DIGITAL INPUTS (SDA, SCL)              |                       |           |     |           |                    |                                                                                                                           |
| Input High Voltage                                | $V_{\text{IH}}$       | 1.1       |     |           | V                  | $I_{\text{OL}} = 4\text{ mA}$                                                                                             |
| Input Low Voltage                                 | $V_{\text{IL}}$       |           |     | 0.8       | V                  |                                                                                                                           |
| Output Low Voltage                                | $V_{\text{OL}}$       |           |     | 0.4       | V                  |                                                                                                                           |
| Input Leakage                                     | $I_{\text{LEAK-PIN}}$ | -10<br>-5 |     | +10<br>+5 | $\mu\text{A}$      |                                                                                                                           |
| Nominal Bus Voltage                               | $V_{\text{DD}}$       | 2.7       |     | 5.5       | V                  | Device is not powered<br>3 V to 5 V $\pm 10\%$                                                                            |
| Capacitance for SDA, SCL Pins                     | $C_{\text{PIN}}$      |           | 5   |           | pF                 |                                                                                                                           |
| Input Glitch Filter                               | $t_{\text{SP}}$       | 0         |     | 50        | ns                 |                                                                                                                           |

## SERIAL BUS TIMING CHARACTERISTICS

Table 2.

| Parameter           | Description        | Min        | Typ | Max | Unit          | Test Conditions/Comments                                                                                  |
|---------------------|--------------------|------------|-----|-----|---------------|-----------------------------------------------------------------------------------------------------------|
| $f_{\text{SCLK}}$   | Clock frequency    |            |     | 400 | kHz           | Following the stop condition of a read transaction<br>Following the stop condition of a write transaction |
| $t_{\text{BUF}}$    | Bus free time      | 1.3<br>4.7 |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{HD;STA}}$ | Start hold time    | 0.6        |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{SU;STA}}$ | Start setup time   | 0.6        |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{SU;STO}}$ | Stop setup time    | 0.6        |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{HD;DAT}}$ | SDA hold time      | 300        |     | 900 | ns            |                                                                                                           |
| $t_{\text{SU;DAT}}$ | SDA setup time     | 100        |     |     | ns            |                                                                                                           |
| $t_{\text{LOW}}$    | SCL low time       | 1.3        |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{HIGH}}$   | SCL high time      | 0.6        |     |     | $\mu\text{s}$ |                                                                                                           |
| $t_{\text{R}}^1$    | SCL, SDA rise time | 20         |     | 300 | ns            |                                                                                                           |
| $t_{\text{F}}$      | SCL, SDA fall time | 20         |     | 300 | ns            |                                                                                                           |

<sup>1</sup>Note:  $t_{\text{R}} = (V_{\text{IL(MAX)}} - 0.15) \text{ to } (V_{\text{IH3V3}} + 0.15)$  and  $t_{\text{F}} = 0.9 V_{\text{DD}} \text{ to } (V_{\text{IL(MAX)}} - 0.15)$ ; where  $V_{\text{IH3V3}} = 2.1\text{ V}$ , and  $V_{\text{DD}} = 3.3\text{ V}$ .

## Timing Diagram

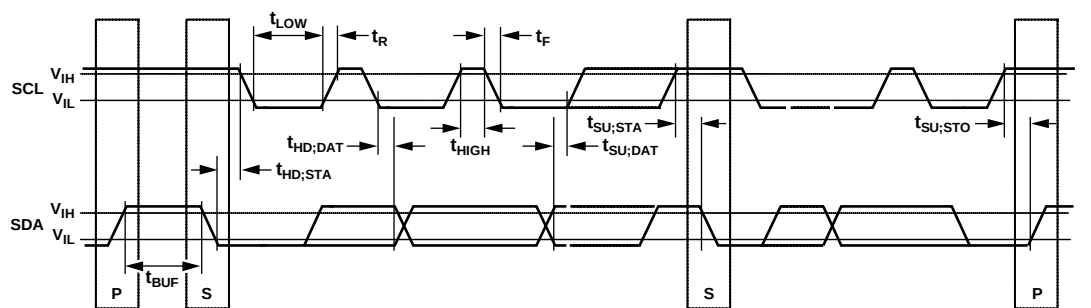


Figure 2. Serial Bus Timing Diagram

## ABSOLUTE MAXIMUM RATINGS

Table 3.

| Parameter                                                       | Rating                 |
|-----------------------------------------------------------------|------------------------|
| VCC Pin                                                         | –0.3 V to +25 V        |
| UV Pin                                                          | –0.3 V to +4 V         |
| OV Pin                                                          | –0.3 V to +4 V         |
| SS Pin                                                          | –0.3 V to VCAP + 0.3 V |
| TIMER Pin                                                       | –0.3 V to VCAP + 0.3 V |
| VCAP Pin                                                        | –0.3 V to +4 V         |
| ISSET Pin                                                       | –0.3 V to VCAP + 0.3 V |
| LATCH Pin                                                       | –0.3 V to +25 V        |
| SCL Pin                                                         | –0.3 V to +6.5 V       |
| SDA Pin                                                         | –0.3 V to +6.5 V       |
| ADR Pin                                                         | –0.3 V to VCAP + 0.3 V |
| ENABLE Pin                                                      | –0.3 V to +25 V        |
| GPO2/ALERT2 Pin                                                 | –0.3 V to +25 V        |
| PWRGD Pin                                                       | –0.3 V to +25 V        |
| FLB Pin                                                         | –0.3 V to +25 V        |
| VOUT Pin                                                        | –0.3 V to +25 V        |
| GATE Pin (Internal Supply Only) <sup>1</sup>                    | –0.3 V to +36 V        |
| SENSE+ Pin                                                      | –0.3 V to +25 V        |
| SENSE– Pin                                                      | –0.3 V to +25 V        |
| V <sub>SENSE</sub> (V <sub>SENSE+</sub> – V <sub>SENSE–</sub> ) | ±0.3 V                 |
| Continuous Current into Any Pin                                 | ±10 mA                 |
| Storage Temperature Range                                       | –65°C to +125°C        |
| Operating Temperature Range                                     | –40°C to +85°C         |
| Lead Temperature, Soldering (10 sec)                            | 300°C                  |
| Junction Temperature                                            | 150°C                  |

<sup>1</sup> The GATE pin has internal clamping circuits to prevent the GATE pin voltage from exceeding the maximum ratings of a MOSFET with V<sub>GSMAX</sub> = 20 V and internal process limits. Applying a voltage source to this pin externally may cause irreversible damage.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

θ<sub>JA</sub> is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 4. Thermal Resistance

| Package Type            | θ <sub>JA</sub> | Unit |
|-------------------------|-----------------|------|
| 20-lead LFCSP (CP-20-9) | 30.4            | °C/W |

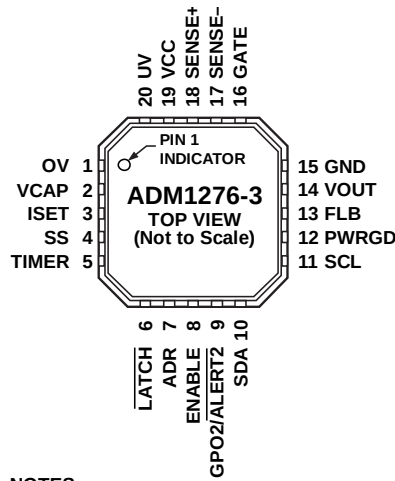
## ESD CAUTION



### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



### NOTES

1. SOLDER THE EXPOSED PADDLE TO THE BOARD TO IMPROVE THERMAL DISSIPATION. THE EXPOSED PADDLE CAN BE CONNECTED TO GROUND.

09718-003

Figure 3. Pin Configuration

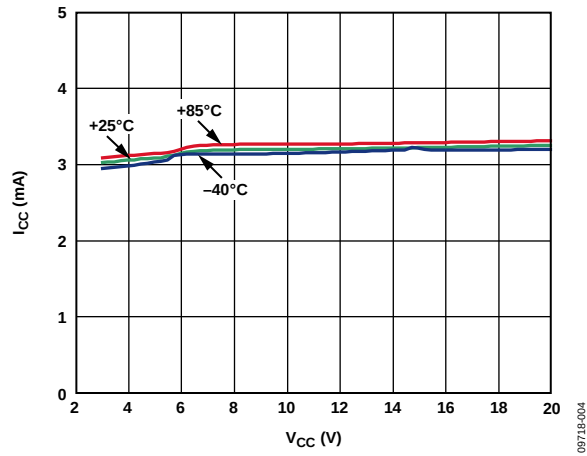
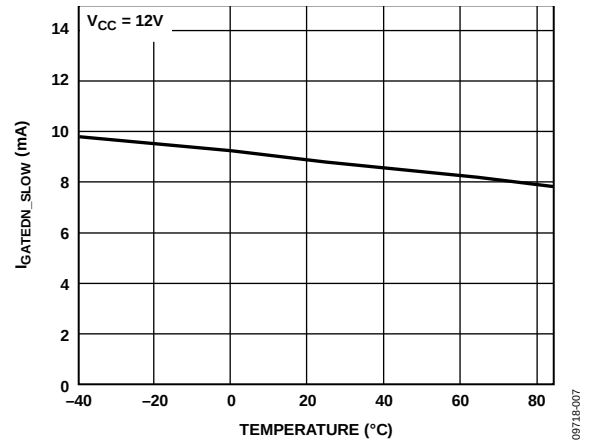
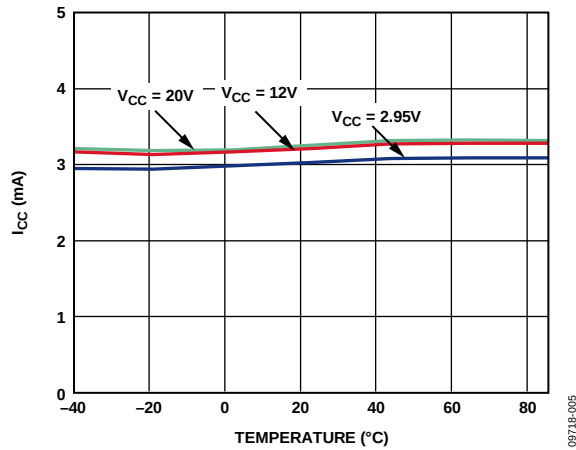
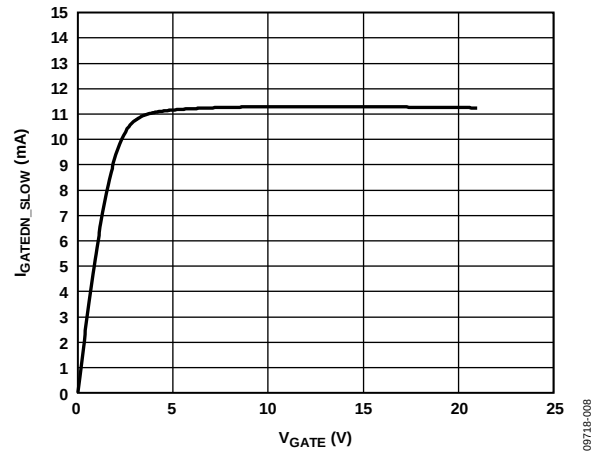
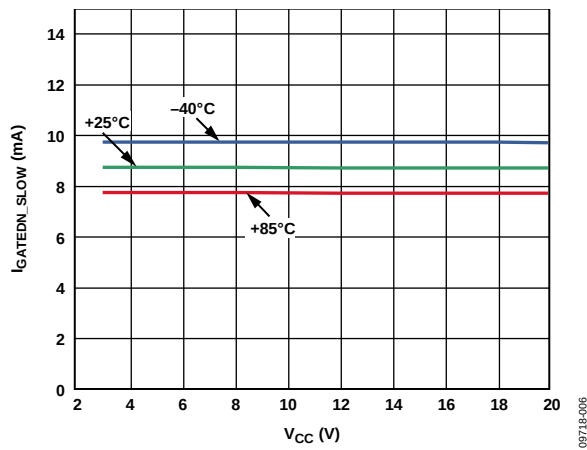
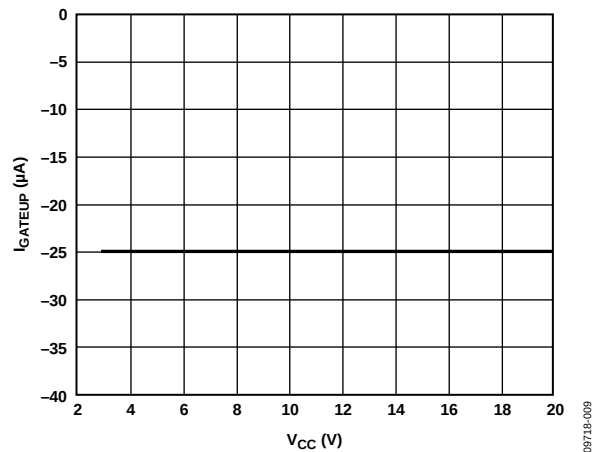
Table 5. Pin Function Descriptions

| Pin No. | Mnemonic    | Description                                                                                                                                                                                                                                                                                                                         |
|---------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 19      | VCC         | Positive Supply Input Pin. An undervoltage lockout (UVLO) circuit resets the device when a low supply voltage is detected. GATE is held low when the supply is below UVLO. During normal operation, this pin should remain greater than or equal to SENSE+ to ensure that specifications are adhered to. No sequencing is required. |
| 20      | UV          | Undervoltage Input Pin. An external resistor divider is used from the supply to this pin to allow an internal comparator to detect whether the supply is under the UV limit.                                                                                                                                                        |
| 1       | OV          | Overvoltage Input Pin. An external resistor divider is used from the supply to this pin to allow an internal comparator to detect whether the supply is above the OV limit.                                                                                                                                                         |
| 2       | VCAP        | Internal Regulated Supply. Place a capacitor with a value of 1 $\mu$ F or greater on this pin to maintain good accuracy. This pin can be used as a reference to program the ISET pin voltage.                                                                                                                                       |
| 3       | ISET        | Current Limit. This pin allows the current-limit threshold to be programmed. The default limit is set when this pin is connected directly to VCAP. To achieve a user defined sense voltage, the current limit can be adjusted using a resistor divider from VCAP. An external reference can also be used.                           |
| 4       | SS          | Soft Start Pin. A capacitor is used on this pin to set the soft start ramp profile. The voltage on the SS pin controls the current sense voltage limit, which controls the inrush current profile.                                                                                                                                  |
| 5       | TIMER       | Timer Pin. An external capacitor, $C_{TIMER}$ , sets an initial timing cycle delay and a fault delay. The GATE pin is pulled low when the voltage on the TIMER pin exceeds the upper threshold.                                                                                                                                     |
| 6       | LATCH       | Latch Pin. This pin signals that the device is latching off after an overcurrent fault. The device can be configured for automatic retry after latch-off by connecting this pin directly to the UV or the ENABLE pin.                                                                                                               |
| 7       | ADR         | PMBus Address Pin. This pin can be tied to GND, tied to VCAP, remain floating, or tied low through a resistor to set four different PMBus addresses (see the Device Addressing section).                                                                                                                                            |
| 8       | ENABLE      | Enable Pin. This pin is a digital logic input. This input must be high to allow the ADM1276 hot swap controller to begin a power-up sequence. If this pin is held low, the ADM1276 is prevented from powering up. There is no internal pull-up on this pin.                                                                         |
| 9       | GPO2/ALERT2 | General-Purpose Digital Output/Alert. This is a dual function pin. There is no internal pull-up on this pin. The ALERT2 function of this pin can be configured to generate an alert signal when one or more fault or warning conditions are detected. At power-up, ALERT2 indicates the FET health mode by default.                 |
| 10      | SDA         | Serial Data Input/Output Pin. Open-drain input/output. Requires an external resistive pull-up.                                                                                                                                                                                                                                      |
| 11      | SCL         | Serial Clock Pin. Open-drain input. Requires an external resistive pull-up.                                                                                                                                                                                                                                                         |
| 12      | PWRGD       | Power-Good Signal. Used to indicate that the supply is within tolerance. This signal is based on the voltage present on the FLB pin.                                                                                                                                                                                                |
| 13      | FLB         | Foldback Pin. A foldback resistor divider is placed from the source of the FET to this pin. Foldback is used to reduce the current limit when the source voltage drops. The foldback feature ensures that the power through the FET is not increased beyond the SOA limits.                                                         |

| Pin No.          | Mnemonic | Description                                                                                                                                                                                                                                                                                                                                                                                                      |
|------------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 14               | VOUT     | Output Voltage. This pin is used to read back the output voltage using the internal ADC. A 1 kΩ resistor should be inserted in series between the source of a FET and the VOUT pin.                                                                                                                                                                                                                              |
| 15               | GND      | Ground Pin.                                                                                                                                                                                                                                                                                                                                                                                                      |
| 16               | GATE     | Gate Output Pin. This pin is the high-side gate drive of an external N-channel FET. This pin is driven by the FET drive controller, which uses a charge pump to provide a pull-up current to charge the FET gate pin. The FET drive controller regulates to a maximum load current by regulating the GATE pin. GATE is held low when the supply is below UVLO.                                                   |
| 17               | SENSE–   | Negative Current Sense Input Pin. A sense resistor between the SENSE+ pin and the SENSE– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1276</a> controls the external FET gate to maintain the sense voltage ( $V_{\text{SENSE+}} - V_{\text{SENSE-}}$ ). This pin also connects to the FET drain pin.                                                                         |
| 18               | SENSE+   | Positive Current Sense Input Pin. This pin connects to the main supply input. A sense resistor between the SENSE+ pin and the SENSE– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1276</a> controls the external FET gate to maintain the sense voltage ( $V_{\text{SENSE+}} - V_{\text{SENSE-}}$ ). This pin is also used to measure the supply input voltage using the ADC. |
| N/A <sup>1</sup> | EP       | Exposed Pad. The exposed pad is located on the underside of the LFCSP package. Solder the exposed pad to the printed circuit board (PCB) to improve thermal dissipation. The exposed pad can be connected to ground.                                                                                                                                                                                             |

<sup>1</sup> N/A means not applicable.

## TYPICAL PERFORMANCE CHARACTERISTICS

Figure 4. Supply Current ( $I_{CC}$ ) vs. Supply Voltage ( $V_{CC}$ )Figure 7. Gate Pull-Down Current ( $I_{GATEDN\_SLOW}$ ) vs. TemperatureFigure 5. Supply Current ( $I_{CC}$ ) vs. TemperatureFigure 8. Gate Pull-Down Current ( $I_{GATEDN\_SLOW}$ ) vs. Gate Voltage ( $V_{GATE}$ )Figure 6. Gate Pull-Down Current ( $I_{GATEDN\_SLOW}$ ) vs. Supply Voltage ( $V_{CC}$ )Figure 9. Gate Pull-Up Current ( $I_{GATEUP}$ ) vs. Supply Voltage ( $V_{CC}$ )

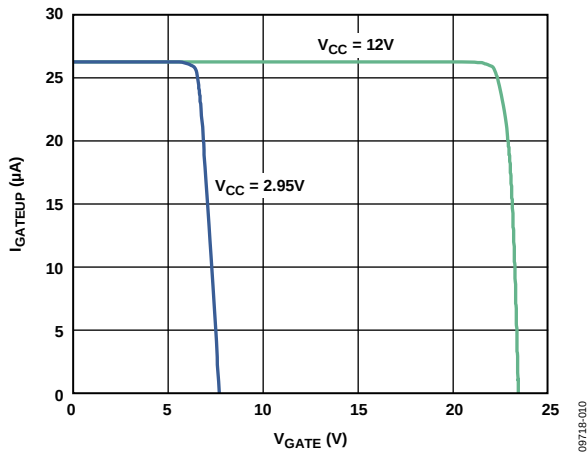


Figure 10. Gate Pull-Up Current ( $I_{GATEUP}$ ) vs. Gate Voltage ( $V_{GATE}$ )

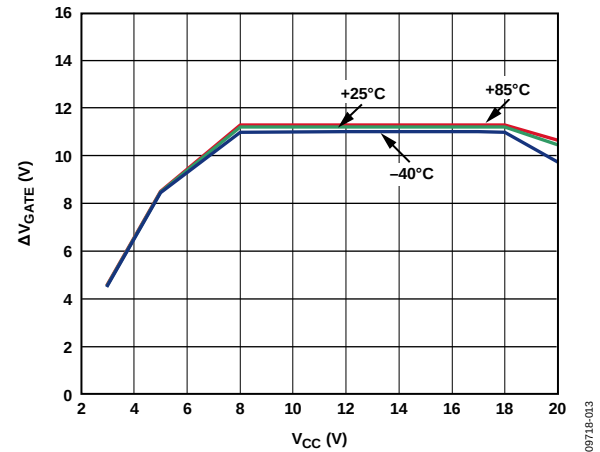


Figure 13. Gate Drive Voltage ( $\Delta V_{GATE}$ ) vs. Supply Voltage ( $V_{CC}$ ), 5  $\mu A$  Load

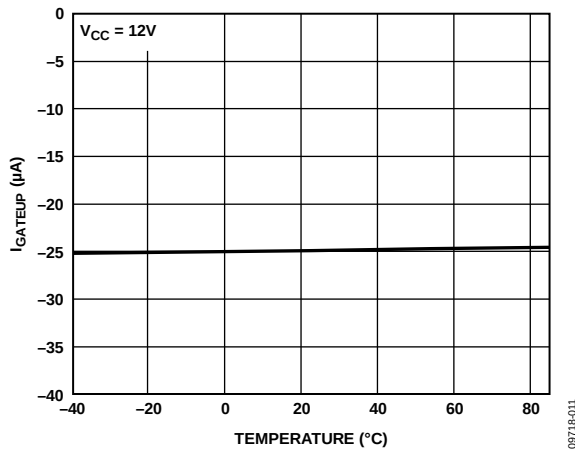


Figure 11. Gate Pull-Up Current ( $I_{GATEUP}$ ) vs. Temperature

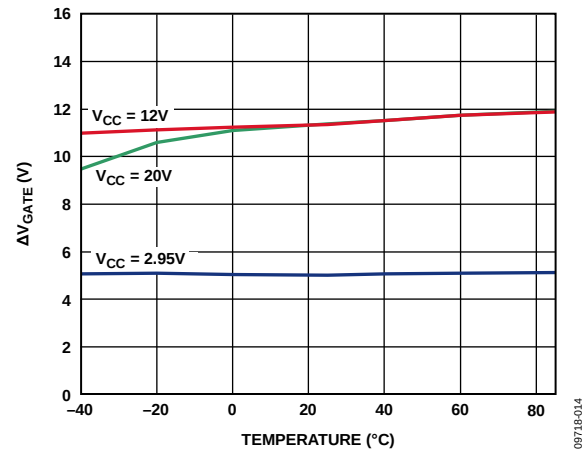


Figure 14. Gate Drive Voltage ( $\Delta V_{GATE}$ ) vs. Temperature, No Load

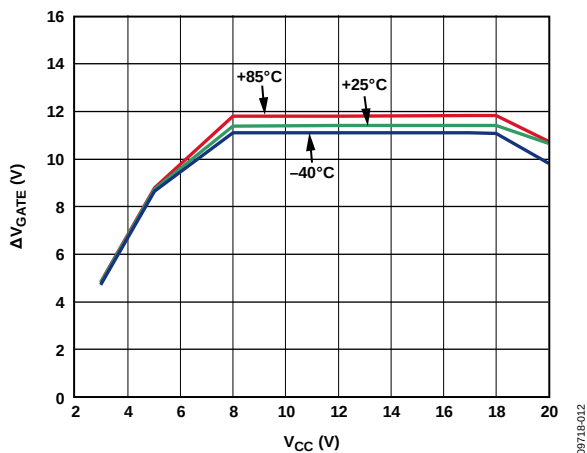


Figure 12. Gate Drive Voltage ( $\Delta V_{GATE}$ ) vs. Supply Voltage ( $V_{CC}$ ), No Load

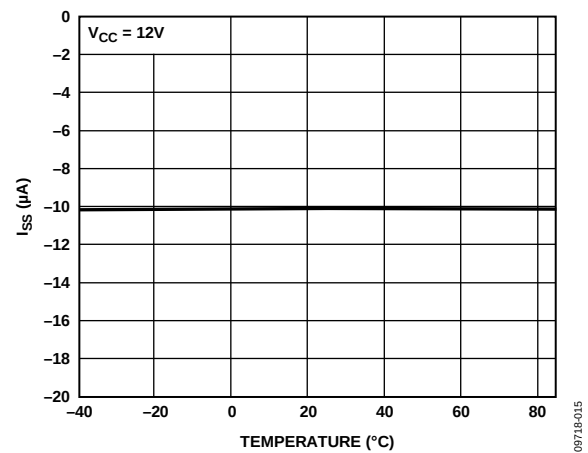


Figure 15. Soft Start Pull-Up Current ( $I_{SS}$ ) vs. Temperature

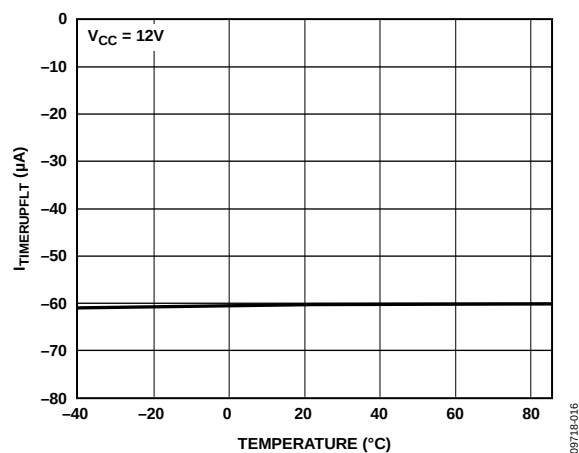


Figure 16. Timer Pull-Up Current, Overcurrent Fault ( $I_{\text{TIMERUPFLT}}$ ) vs. Temperature

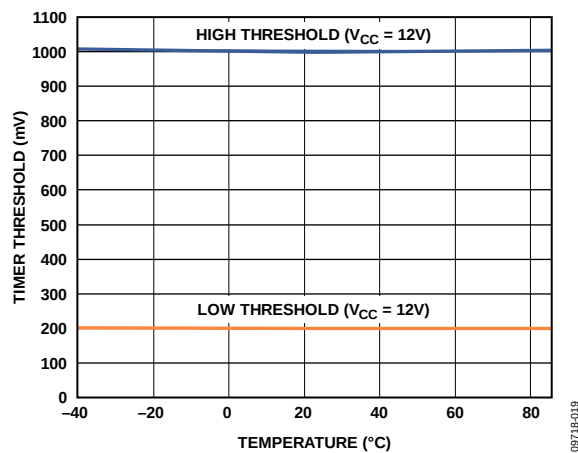


Figure 19. Timer Thresholds vs. Temperature

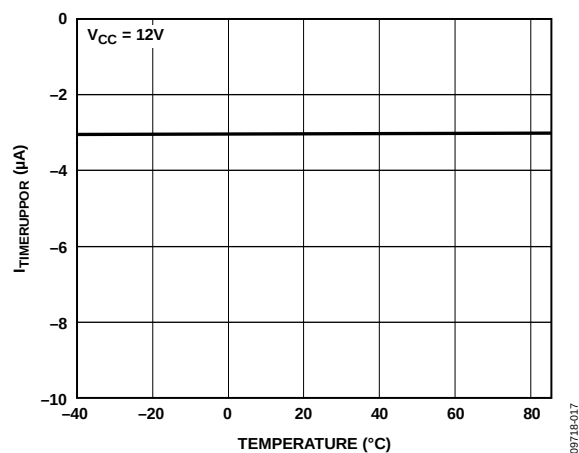


Figure 17. Timer Pull-Up Current, Power-On Reset ( $I_{\text{TIMERUPPOR}}$ ) vs. Temperature

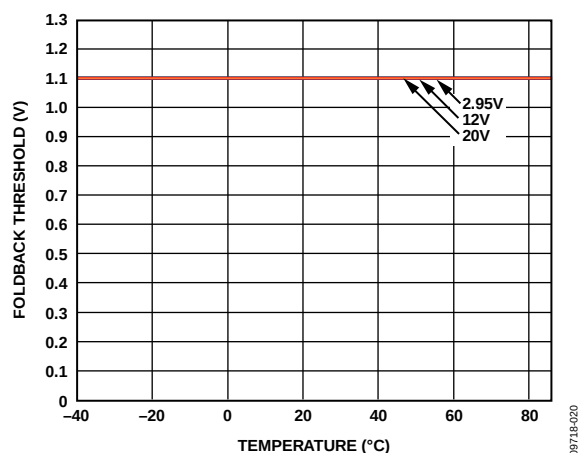


Figure 20. Foldback Threshold vs. Temperature

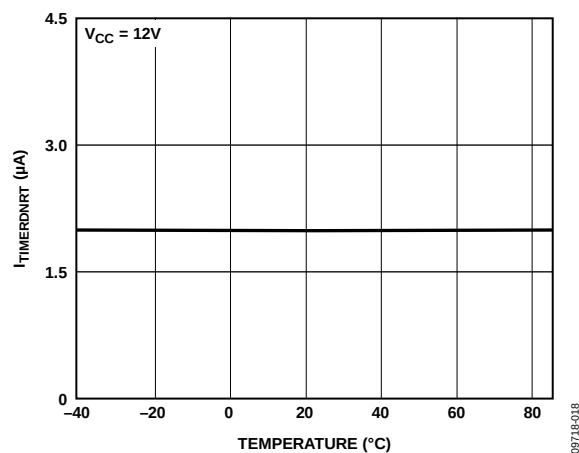


Figure 18. Timer Pull-Down Current, Retry ( $I_{\text{TIMERDNRT}}$ ) vs. Temperature

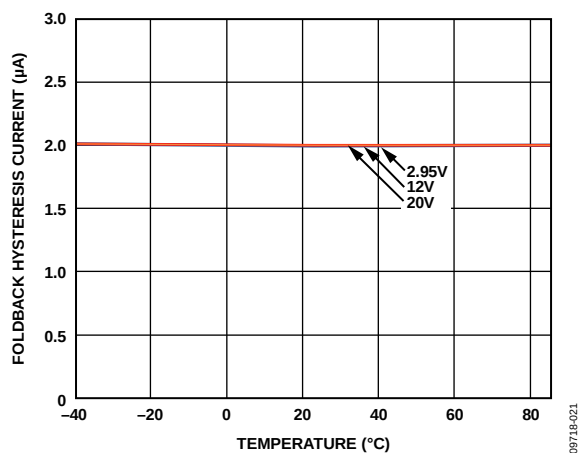


Figure 21. Foldback Hysteresis Current vs. Temperature

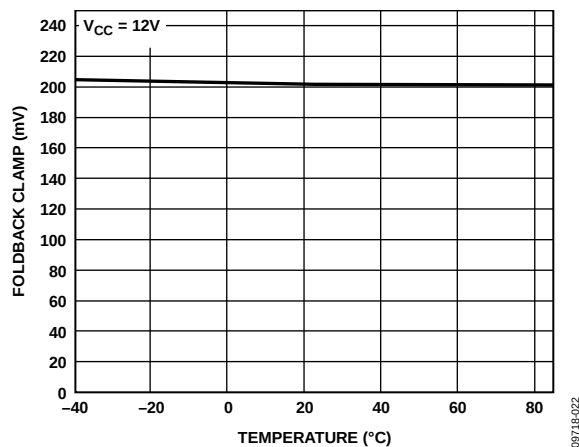


Figure 22. Foldback Clamp vs. Temperature

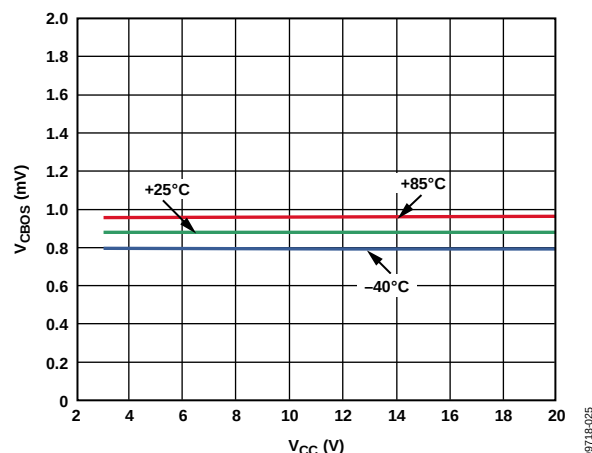


Figure 25. Circuit Breaker Offset ( $V_{CBOs}$ ) vs. Supply Voltage ( $V_{CC}$ )

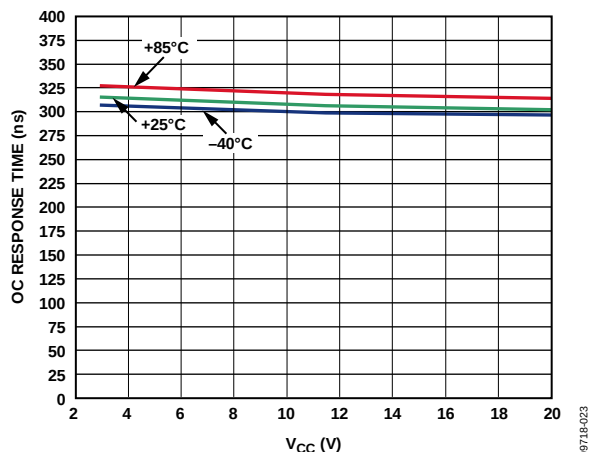


Figure 23. Severe Overcurrent Response Time vs. Supply Voltage ( $V_{CC}$ ),  $V_{ISET} = 0.25 V$

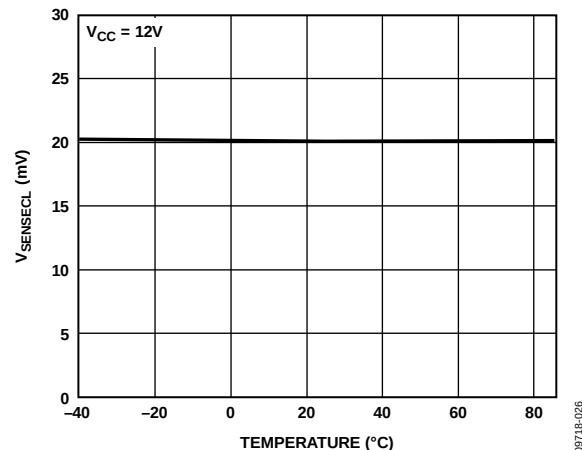


Figure 26. Hot Swap Sense Voltage Current Limit ( $V_{SENSECL}$ ) vs. Temperature

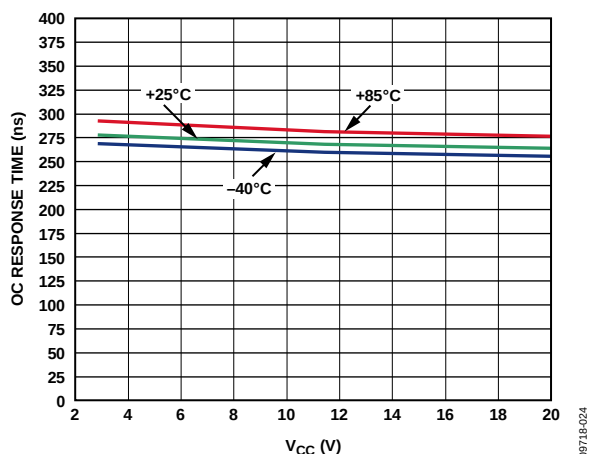


Figure 24. Severe Overcurrent Response Time vs. Supply Voltage ( $V_{CC}$ ),  $V_{ISET} = 1 V$

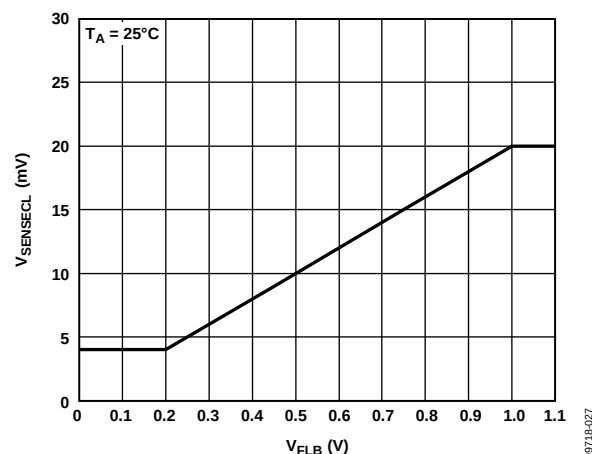


Figure 27. Hot Swap Sense Voltage Current Limit ( $V_{SENSECL}$ ) vs. Foldback Voltage ( $V_{FLB}$ )

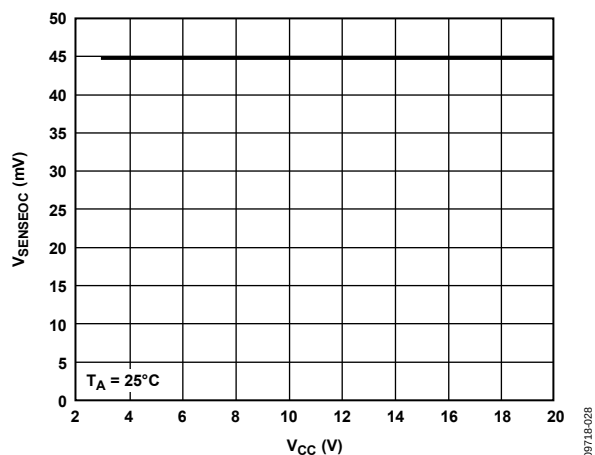


Figure 28. Severe Overcurrent Voltage Threshold ( $V_{SENSEOC}$ ) vs. Supply Voltage ( $V_{CC}$ ),  $V_{ISET} = V_{VCAP}$

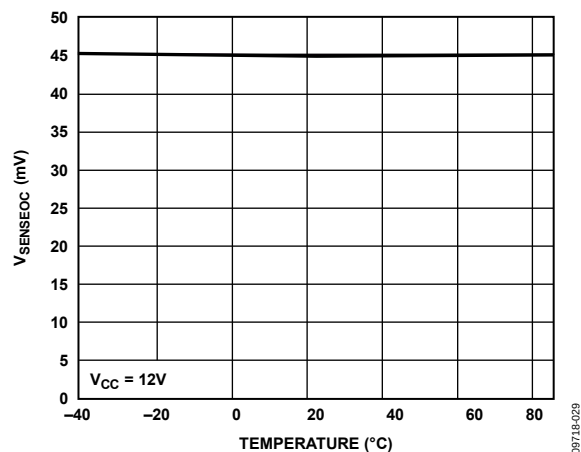


Figure 29. Severe Overcurrent Voltage Threshold ( $V_{SENSEOC}$ ) vs. Temperature,  $V_{ISET} = V_{VCAP}$

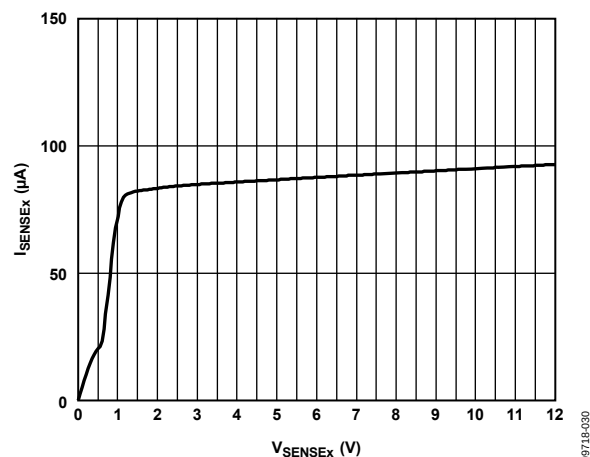


Figure 30. SENSE+ / SENSE- Input Current ( $I_{SENSEX}$ ) vs. Voltage ( $V_{SENSEX}$ )

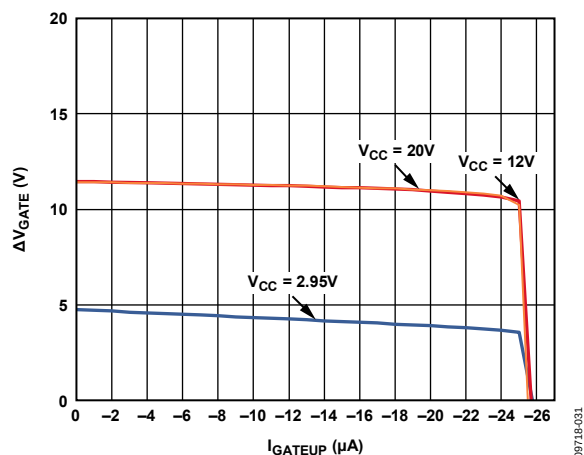


Figure 31. Gate Drive Voltage ( $\Delta V_{GATE}$ ) vs. Gate Pull-Up Current ( $I_{GATEUP}$ )

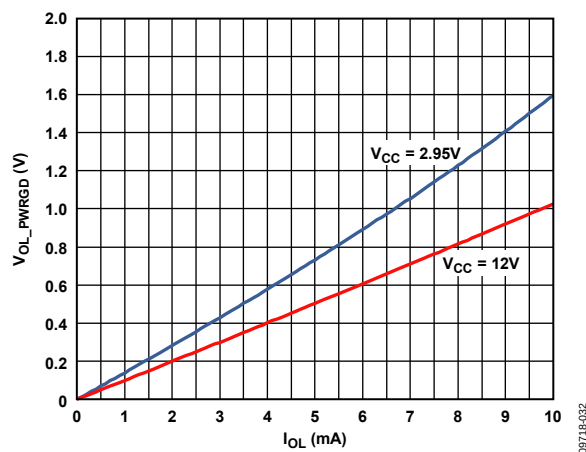


Figure 32. PWRGD Pin,  $V_{OL}$  vs.  $I_{OL}$

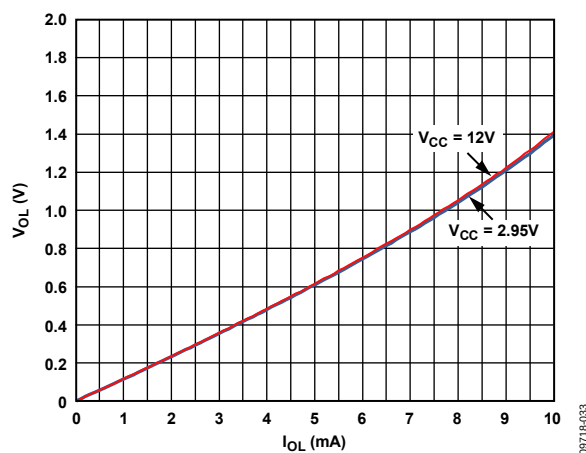


Figure 33. LATCH and GPO2 / ALERT2 Digital Outputs,  $V_{OL}$  vs.  $I_{OL}$

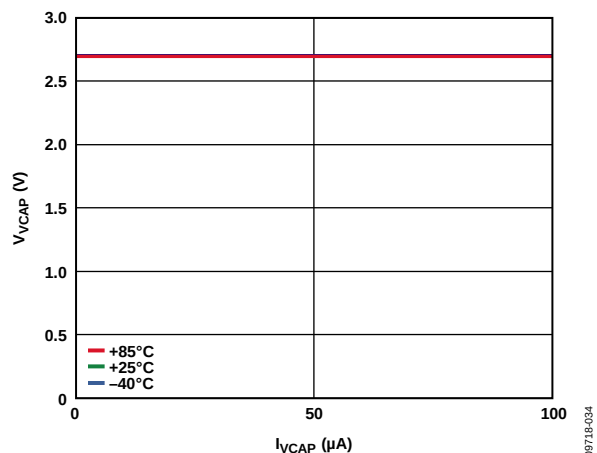


Figure 34. VCAP Voltage ( $V_{VCAP}$ ) vs. VCAP Load ( $I_{VCAP}$ )

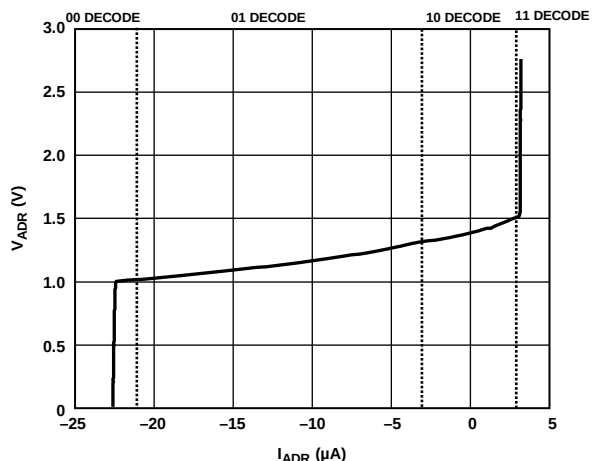


Figure 37. ADR Pin Voltage ( $V_{ADR}$ ) vs. Current ( $I_{ADR}$ )

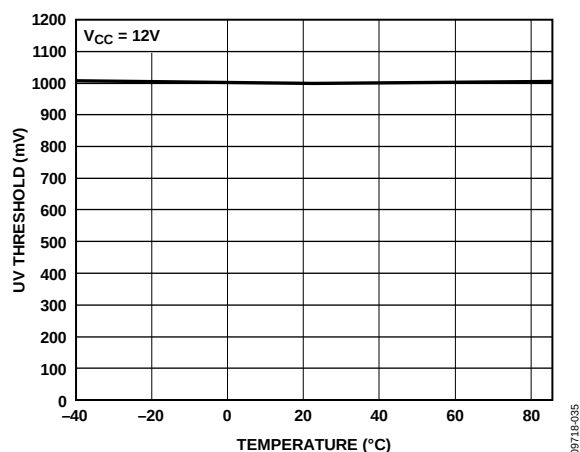


Figure 35. UV Threshold ( $UV_{TH}$ ) vs. Temperature

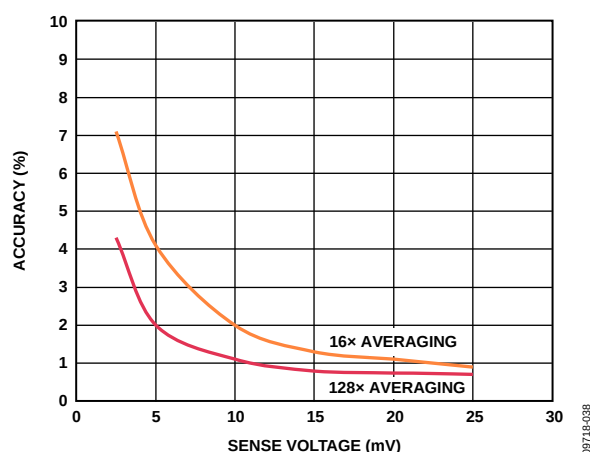


Figure 38. Worst-Case Current Sense Power Monitor Error vs. Current Sense Voltage ( $V_{SENSE}$ ), 0°C to 65°C,  $V_{SENSE+} = 12V$

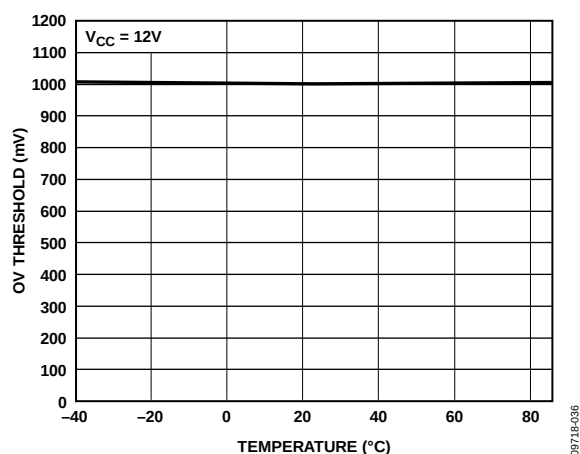


Figure 36. OV Threshold ( $OV_{TH}$ ) vs. Temperature

## TYPICAL APPLICATION CIRCUIT

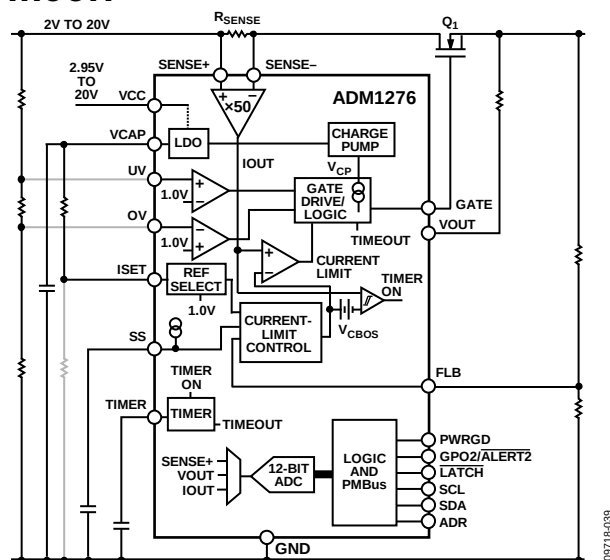


Figure 39. Typical Application Circuit

## THEORY OF OPERATION

When circuit boards are inserted into a live backplane, discharged supply bypass capacitors draw large transient currents from the backplane power bus as they charge. These transient currents can cause permanent damage to connector pins, as well as dips on the backplane supply that can reset other boards in the system.

The ADM1276 is designed to control the powering on and off of a system in a controlled manner, allowing a board to be removed from, or inserted into, a live backplane by protecting it from excess currents. The ADM1276 can reside on the backplane or on the removable board.

### POWERING THE ADM1276

A supply voltage from 2.95 V to 20 V is required to power the ADM1276 via the VCC pin. The VCC pin provides the majority of the bias current for the device; the remainder of the current needed to control the gate drive and best regulate the  $V_{GS}$  voltage is supplied by the SENSE+ pin.

To ensure correct operation of the ADM1276, the voltage on the VCC pin must be greater than or equal to the voltage on the SENSE+ pin. No sequencing of the VCC and SENSE+ rails is necessary. The SENSE+ pin can be as low as 2 V for normal operation provided that a voltage of at least 2.95 V is connected to the VCC pin. In most applications, both the VCC and SENSE+ pins are connected to the same voltage rail, but they are connected via separate traces to prevent accuracy loss in the sense voltage measurement (see Figure 40).

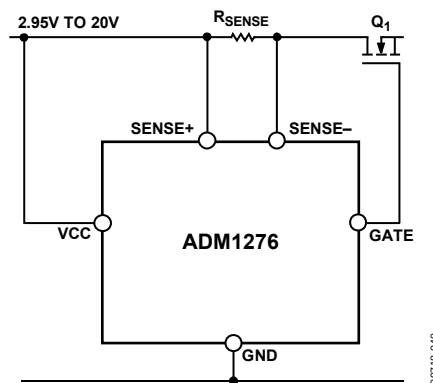


Figure 40. Powering the ADM1276

To protect the ADM1276 from unnecessary resets due to transient supply glitches, an external resistor and capacitor can be added, as shown in Figure 41. Choose the values of these components so as to provide a time constant that can filter any expected glitches. The resistor should, however, be small enough to keep voltage drops due to quiescent current to a minimum. Unless a resistor is used to limit the inrush current, do not place a supply decoupling capacitor on the rail before the FET.

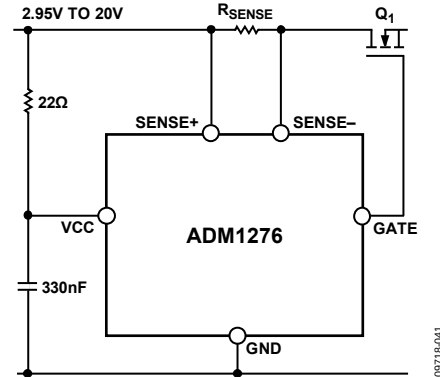


Figure 41. Transient Glitch Protection Using an RC Network

### CURRENT SENSE INPUTS

The load current is monitored by measuring the voltage drop across an external sense resistor,  $R_{SENSE}$  (see Figure 42). An internal current sense amplifier provides a gain of 50 to the voltage drop detected across  $R_{SENSE}$ . The result is compared to an internal reference and used by the hot swap control logic to detect when an overcurrent condition occurs.

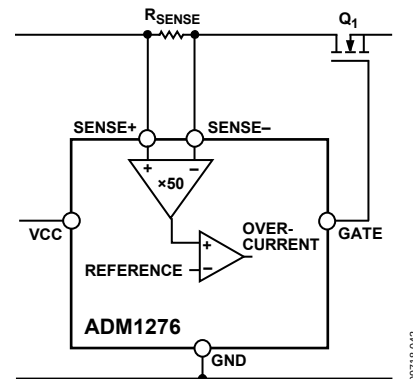


Figure 42. Hot Swap Current Sense Amplifier

The SENSE± inputs may be connected to multiple parallel sense resistors, which can affect the voltage drop detected by the ADM1276. The current flowing through the sense resistors creates an offset, resulting in reduced accuracy.

To achieve better accuracy, the averaging resistors sum the current from the nodes of each sense resistor, as shown in Figure 43. The typical value for the averaging resistors is 10 Ω. The averaging resistors are chosen to balance the input current to both sense pins to within 5 μA. This ensures that the same offset is seen by both sense inputs.

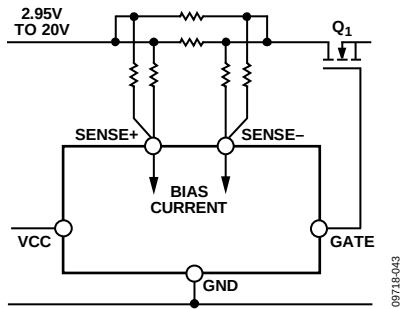


Figure 43. Connection of Multiple Sense Resistors to the SENSE± Pins

## CURRENT-LIMIT REFERENCE

The current-limit reference voltage determines the load current level to which the ADM1276 limits the current during an over-current event. This reference voltage is compared to the gained-up current sense voltage to determine whether the limit is reached.

An internal current-limit reference selector block continuously compares the ISET, soft start, and foldback voltages to determine which voltage is the lowest at any given time; the lowest voltage is used as the current-limit reference. This ensures that the programmed current limit, ISET, is used in normal operation, and that the soft start and foldback features reduce the current limit when required during startup and/or fault conditions.

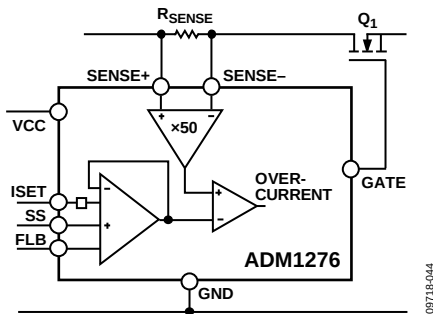


Figure 44. Current-Limit Reference Selection

The foldback and soft start voltages vary during different modes of operation and are, therefore, clamped to minimum levels of 200 mV and 100 mV, respectively, to prevent zero current flow due to the current limit being too low. Figure 45 provides an example of how the soft start, foldback, and ISET voltages interact during startup as the ADM1276 is enhancing the FET and charging the load capacitances. Depending on how the soft start and foldback features are configured, the hand-off point can vary to ensure that the FET is being operated within the correct limits.

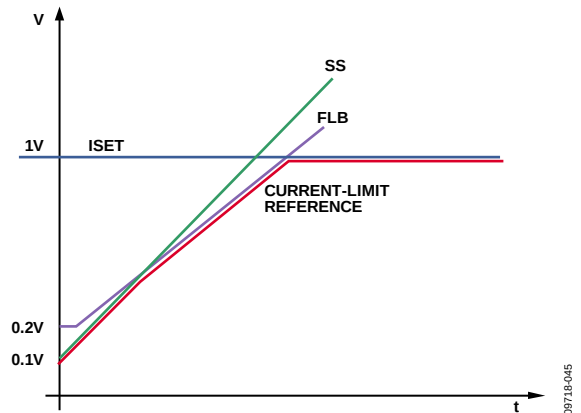


Figure 45. Interaction of Soft Start, Foldback, and ISET Current Limits

## SETTING THE CURRENT LIMIT (ISET)

The maximum current limit is partially determined by selecting a sense resistor to match the current sense voltage limit on the controller for the desired load current. However, as currents become larger, the sense resistor requirements become smaller, and resolution can be difficult to achieve when selecting the appropriate sense resistor. The ADM1276 provides an adjustable current sense voltage limit to handle this issue. The device allows the user to program the required current sense voltage limit from 5 mV to 25 mV.

The default value of 20 mV is achieved by connecting the ISET pin directly to the VCAP pin. This configures the device to use an internal 1 V reference, which equates to 20 mV at the sense inputs (see Figure 46).

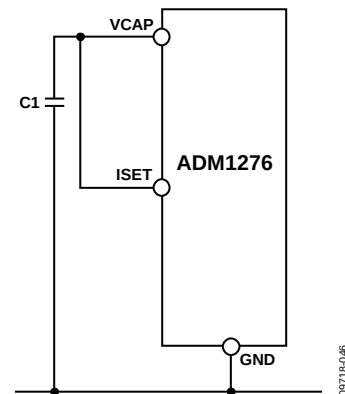


Figure 46. Fixed 20 mV Current Sense Limit

To program the sense voltage from 5 mV to 25 mV, a resistor divider is used to set a reference voltage on the ISET pin (see Figure 47).

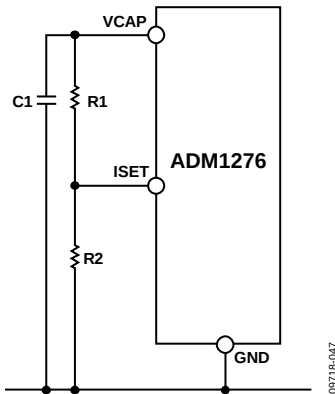


Figure 47. Adjustable 5 mV to 25 mV Current Sense Limit

The VCAP pin has a 2.7 V internal generated voltage that can be used to set a voltage at the ISET pin. Assuming that  $V_{ISET}$  equals the voltage on the ISET pin, size the resistor divider to set the ISET voltage as follows:

$$V_{ISET} = V_{SENSE} \times 50$$

where  $V_{SENSE}$  is the current sense voltage limit.

The VCAP rail can also be used as the pull-up supply for setting the I<sup>2</sup>C address. Do not use the VCAP pin for any other purpose. To guarantee accuracy specifications, do not load the VCAP pin by more than 100  $\mu$ A.

## SOFT START

A capacitor connected to the SS pin determines the inrush current profile. Before the FET is enabled, the output voltage of the current-limit reference selector block is clamped at 100 mV. This, in turn, holds the hot swap sense voltage current limit,  $V_{SENSECL}$ , at approximately 2 mV. When the FET receives a request to turn on, the SS pin is held at ground until the voltage between the SENSE+ and SENSE- pins ( $V_{SENSE}$ ) reaches the circuit breaker voltage,  $V_{CB}$ .

$$V_{CB} = V_{SENSECL} - V_{CBOS}$$

where  $V_{CBOS}$  is typically 0.88 mV, making  $V_{CB} = 1.12$  mV.

When the load current generates a sense voltage equal to  $V_{CB}$ , a 10  $\mu$ A current source is enabled, which charges the SS capacitor and results in a linear ramping voltage on the SS pin. The current-limit reference also ramps up accordingly, allowing the regulated load current to ramp up while avoiding sudden transients during power-up. The SS capacitor value is given by

$$C_{SS} = \frac{I_{SS} \times t}{V_{ISET}}$$

where:

$I_{SS} = 10 \mu$ A.

$t$  = SS ramp time.

For example, a 10 nF capacitor gives a soft start time of 1 ms.

Note that the SS voltage may intersect with the FLB (foldback) voltage, and the current-limit reference may change to follow

FLB (see Figure 45). This change has minimal impact on startup because the output voltage rises at a similar rate to the SS voltage.

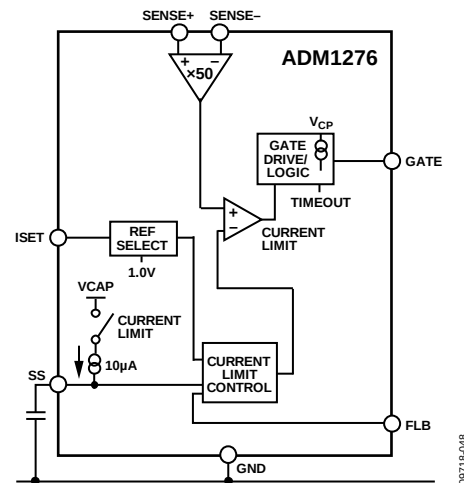


Figure 48. Soft Start

## FOLDBACK

Foldback is a method to actively reduce the current limit as the voltage drop across the FET increases. It keeps the power across the FET to a minimum during power-up, overcurrent, or short-circuit events. It also avoids the need to oversize the FET to accommodate worst-case conditions, resulting in board size and cost savings.

The ADM1276 detects the voltage drop across the FET by looking at a resistor divided version of the output voltage. It is assumed that the supply voltage remains constant and within tolerance. The device, therefore, relies on the principle that the drain of the FET is at the maximum expected supply voltage, and that the magnitude of the output voltage is relative to that of the  $V_{DS}$  of the FET. Using a resistor divider from the output voltage to the FLB pin, a relationship from  $V_{OUT}$ , and thus  $V_{DS}$ , to  $V_{FLB}$  can be derived.

Design the resistor divider to output a voltage equal to ISET when  $V_{OUT}$  falls below the desired level. This should be well below the working tolerance of the supply rail. As  $V_{OUT}$  continues to drop, the current-limit reference follows  $V_{FLB}$  because it is now the lowest voltage input to the current-limit reference selector block. This results in a reduction of the current limit and, therefore, the regulated load current. To prevent complete current flow restriction, a clamp becomes active when the current-limit reference reaches 200 mV. The current limit cannot drop below this level.

To suit the SOA characteristics of a particular FET, the required minimum current for this clamp varies from design to design. However, the current-limit reference fixes this clamp at 200 mV, which equates to 4 mV at the sense resistor. Therefore, the main ISET voltage can be adjusted to align this clamp to the required percentage current reduction. For example, if ISET equals 0.8 V, the clamp can be set at 25% of the maximum current.

## TIMER

The TIMER pin handles several timing functions with an external capacitor,  $C_{TIMER}$ . The two comparator thresholds are  $V_{TIMERL}$  (0.2 V) and  $V_{TIMERH}$  (1 V). There are four timing current sources: a 3  $\mu$ A pull-up, a 60  $\mu$ A pull-up, a 2  $\mu$ A pull-down, and a 100  $\mu$ A pull-down.

These current and voltage levels, together with the value of  $C_{TIMER}$  chosen by the user, determine the initial timing cycle time, the fault current-limit time, and the hot swap retry duty cycle. The TIMER pin capacitor value is determined using the following equation:

$$C_{TIMER} = (t_{ON} \times 60 \mu A) / V_{TIMERH}$$

where  $t_{ON}$  is the time that the FET is allowed to spend in regulation at the set current limit.

The choice of FET is based on matching this time with the SOA requirements of the FET. Foldback can be used to simplify the selection.

When VCC is connected to the backplane supply, the internal supply of the ADM1276 must be charged up. In a very short time, the internal supply is fully charged up and, because the undervoltage lockout (UVLO) voltage is exceeded at VCC, the device emerges from reset. During this first short reset period, the GATE and TIMER pins are both held low.

The ADM1276 then goes through an initial timing cycle. The TIMER pin is pulled high with 3  $\mu$ A. When the TIMER pin reaches the  $V_{TIMERH}$  threshold (1.0 V), the first portion of the initial timing cycle is complete. The 100  $\mu$ A current source then pulls down the TIMER pin until it reaches  $V_{TIMERL}$  (0.2 V). The initial timing cycle duration is related to  $C_{TIMER}$  by the following equation:

$$t_{INITIAL} = \frac{V_{TIMERH} \times C_{TIMER}}{3 \mu A} + \frac{(V_{TIMERH} - V_{TIMERL}) \times C_{TIMER}}{100 \mu A}$$

For example, a 100 nF capacitor results in a delay of approximately 34 ms. If the UV and OV inputs indicate that the supply is within the defined window of operation when the initial timing cycle terminates, the device is ready to start a hot swap operation.

When the voltage across the sense resistor reaches the circuit breaker trip voltage,  $V_{CB}$ , the 60  $\mu$ A timer pull-up current is activated, and the gate begins to regulate the current at the current limit. This initiates a ramp-up on the TIMER pin. If the sense voltage falls below this circuit breaker trip voltage before the TIMER pin reaches  $V_{TIMERH}$ , the 60  $\mu$ A pull-up is disabled and the 2  $\mu$ A pull-down is enabled.

The circuit breaker trip voltage is not the same as the hot swap sense voltage current limit. There is a small circuit breaker offset,  $V_{CBOS}$ , which means that the timer actually starts a short time before the current reaches the defined current limit.

However, if the overcurrent condition is continuous and the sense voltage remains above the circuit breaker trip voltage, the 60  $\mu$ A pull-up remains active and the FET remains in regulation.

This allows the TIMER pin to reach  $V_{TIMERH}$  and initiate the GATE shutdown. On the ADM1276, the LATCH pin is pulled low immediately.

In latch-off mode, the TIMER pin is switched to the 2  $\mu$ A pull-down when it reaches the  $V_{TIMERH}$  threshold. The LATCH pin remains low. While the TIMER pin is being pulled down, the hot swap controller remains off and cannot be turned back on.

When the voltage on the TIMER pin goes below the  $V_{TIMERL}$  threshold, the hot swap controller can be reenabled by toggling the UV pin or by using the PMBus OPERATION command to toggle the on bit from on to off and then on again.

## HOT SWAP RETRY DUTY CYCLE

The ADM1276 turns off the FET after an overcurrent fault and then uses the capacitor on the TIMER pin to provide a delay before automatically retrying the hot swap operation. To configure the ADM1276 for autoretry mode, the LATCH pin is tied to either the UV pin or to the ENABLE pin. Note that a pull-up resistor is required on the LATCH pin.

When an overcurrent fault occurs, the capacitor on the TIMER pin is charged with a 60  $\mu$ A pull-up current. When the TIMER pin reaches  $V_{TIMERH}$ , the GATE pin is pulled down. When the LATCH pin is tied to the UV pin or the ENABLE pin for autoretry mode, the TIMER pin is pulled down with a 2  $\mu$ A current sink. When the TIMER pin reaches  $V_{TIMERL}$  (0.2 V), it automatically restarts the hot swap operation.

The duty cycle of this automatic retry cycle is set by the ratio of 2  $\mu$ A/60  $\mu$ A, which approximates to being on about 4% of the time. The value of the timer capacitor determines the on time of this cycle, which is calculated as follows:

$$t_{ON} = V_{TIMERH} \times (C_{TIMER}/60 \mu A)$$

$$t_{OFF} = (V_{TIMERH} - V_{TIMERL}) \times (C_{TIMER}/2 \mu A)$$

A 100 nF capacitor on the TIMER pin gives an on time of 1.67 ms and an off time of 40 ms. The device retries indefinitely in this manner and can be disabled manually by holding the UV or ENABLE pin low, or by disconnecting the LATCH pin. To prevent thermal stress, an RC network can be used to extend the retry time to any desired level.

## FET GATE DRIVE CLAMPS

The charge pump used on the GATE pin is capable of driving the pin to  $V_{CC} + (2 \times V_{CC})$ , but it is clamped to less than 14 V above the SENSE $\pm$  pins and less than 31 V. These clamps ensure that the maximum  $V_{GS}$  rating of the FET is not exceeded.

## FAST RESPONSE TO SEVERE OVERCURRENT

The ADM1276 features a separate high bandwidth current sense amplifier that is used to detect a severe overcurrent that is indicative of a short-circuit condition. A fast response time allows the ADM1276 to handle events of this type that could otherwise cause catastrophic damage if not detected and acted on very quickly. The fast response circuit ensures that the ADM1276 can detect an overcurrent event at approximately 200% to 250% of the normal current limit (ISET) and can respond to and control the current within 1  $\mu$ s, in most cases.

## UNDERVOLTAGE AND OVERVOLTAGE

The ADM1276 monitors the supply voltage for undervoltage (UV) and overvoltage (OV) conditions. The UV and OV pins are connected to the input of an internal voltage comparator, and its voltage level is internally compared with a 1 V voltage reference.

Figure 49 illustrates the voltage monitoring input connections. An external resistor network divides the supply voltage for monitoring. An undervoltage event is detected when the voltage connected to the UV pin falls below 1 V, and the gate is shut down using the 10 mA pull-down device. Similarly, when an overvoltage event occurs and the voltage on the OV pin exceeds 1 V, the gate is shut down using the 10 mA pull-down device.

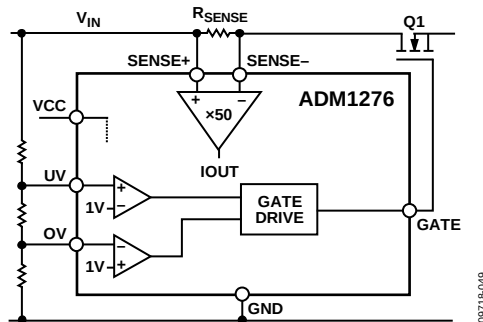


Figure 49. Undervoltage and Overvoltage Supply Monitoring

## ENABLE INPUT

The ADM1276 provides a dedicated ENABLE digital input pin. The ENABLE pin allows the ADM1276 to remain off by using a hardware signal, even when the voltage on the UV pin is above 1.0 V and the voltage on the OV pin is less than 1.0 V. Although the UV pin can be used to provide a digital enable signal, using the ENABLE pin for this purpose means that the ability to monitor for undervoltage conditions is not lost.

In addition to the conditions for the UV and OV pins, the ADM1276 ENABLE input pin must be high for the device to begin a power-up sequence.

A similar function can be achieved using the UV pin directly. Alternatively, if the UV divider function is still required, the configuration shown in Figure 50 can be used.

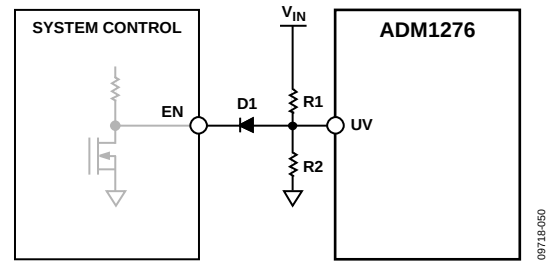


Figure 50. Using the UV Pin as an Enable

Diode D1 prevents the external driver pull-up from affecting the UV threshold. Select Diode D1 using the following criteria:

$$(V_F \times D1) + (V_{OL} \times EN) < 1.0 \text{ V } (I_F = V_{IN}/R1)$$

Ensure that the EN sink current does not exceed the specified  $V_{OL}$  value. If the open-drain device has no pull-up, the diode is not required.

## POWER GOOD

The power good (PWRGD) output can be used to indicate whether the output voltage is above a user-defined threshold and can, therefore, be considered good. The PWRGD output is derived using the FLB resistor network, composed of R1 and R2 (see Figure 51).

The PWRGD pin is an open-drain output that pulls low when the voltage at the FLB pin is lower than  $1.1 \times V_{ISET}$  (power bad). When the voltage at the FLB pin is above this threshold (indicating that the output voltage has risen), the open-drain pull-down is disabled, allowing PWRGD to be pulled high. PWRGD is guaranteed to be in a valid state for  $V_{CC} \geq 1 \text{ V}$ .

Hysteresis on the FLB pin is provided by a 2  $\mu$ A internal current source that is switched on when the  $V_{FLB}$  input voltage exceeds the input threshold. The current source is disconnected when  $V_{OUT}$  drops below the foldback threshold voltage minus the hysteresis voltage. Resistor R3 is internal to the ADM1276. The hysteresis voltage at the FLB pin can be varied by adjusting the parallel combination of Resistor R1 and Resistor R2.

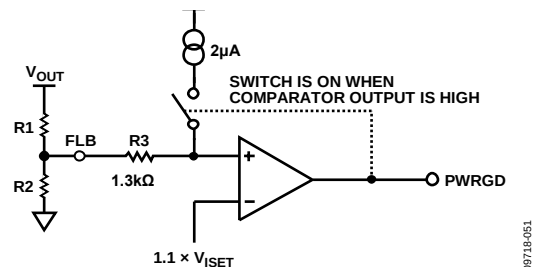


Figure 51. Generation of PWRGD Signal

## VOUT MEASUREMENT

The VOUT pin on the [ADM1276](#) can be used to provide an alternate voltage for the power monitor to measure. The user can choose to measure the voltage at the SENSE+ pin or the voltage at the VOUT pin, using either the low or high input voltage range.

If the VOUT pin is to be used to measure the output voltage after the FET, insert a 1 k $\Omega$  resistor in series between the source of the FET and the VOUT pin. This resistor provides some separation between the [ADM1276](#) and the FET source during a fault condition; thus, [ADM1276](#) operation is not affected.

## FET HEALTH

The [ADM1276](#) provides a method of detecting a shorted pass FET. The FET health status can be used to generate an alert on the GPO2/ALERT2 pin. By default at power-up, an alert is generated on the GPO2/ALERT2 pin of the [ADM1276](#) when the FET health status indicates that a bad FET is present. FET health is considered bad if all of the following conditions are true:

- The [ADM1276](#) is holding the FET off, for example, during the initial power-on cycle time.
- $V_{\text{SENSE}} > 2 \text{ mV}$ .
- $V_{\text{GATE}} < \sim 1 \text{ V}$ , that is, less than the FET gate threshold.

## POWER MONITOR

The [ADM1276](#) features an integrated ADC that accurately measures the current sense voltage, the input voltage, and (optionally) the output voltage. The measured input voltage and current being delivered to the load are multiplied to give a power value that can be read back. Each power value is also added to an accumulator that can be read back to allow an external device to calculate the energy consumption of the load.

The [ADM1276](#) can report the measured current, input voltage, and the output voltage. The PEAK\_IOUT, PEAK\_VIN, and PEAK\_VOUT commands can be used to read the highest peak current or voltage since the value was last cleared.

An averaging function is provided for voltage and current that allows a number of samples to be averaged by the [ADM1276](#). This function reduces the need for postprocessing of sampled data by the host processor. The number of samples that can be averaged is  $2^N$ , where N is in the range of 0 to 7.

The power monitor current sense amplifier is bipolar and can measure both positive and negative currents. The power monitor amplifier has an input range of  $\pm 25 \text{ mV}$ .

Two input voltage ranges are available and can be selected using the PMBus interface: 0 V to 6 V (low input range) and 0 V to 20 V (high input range).

The two basic modes of operation for the power monitor are single shot and continuous. In single shot mode, the power monitor samples the input voltage and current a number of times, depending on the averaging value selected by the user. The [ADM1276](#) returns a single value corresponding to the average voltage and current measured. When configured for continuous mode, the power monitor continuously samples voltage and current, making the most recent sample available to be read.

The single shot mode can be triggered in a number of ways. The simplest is by selecting the single shot mode using the PMON\_CONFIG command and writing to the convert bit using the PMON\_CONTROL command. The convert bit can also be written as part of a PMBus group command. Using a group command allows multiple devices to be written to as part of the same I<sup>2</sup>C bus transaction, with all devices executing the command when the stop condition appears on the bus. In this way, several devices can be triggered to sample at the same time.

Each time a current sense and input voltage measurements are taken, a power calculation is performed, multiplying the two measurements together. This can be read from the device using the READ\_PIN command, returning the input power.

At the same time, the calculated power value is added to a power accumulator register, that may increment a rollover counter if the value exceeds the maximum accumulator value, and that also increments a power sample counter.

The power accumulator and power sample counter are read using the same READ\_EIN command to ensure that the accumulated value and sample count are from the same point in time. The bus host reading the data assigns a timestamp to when the data is read. By calculating the time difference between consecutive uses of READ\_EIN, and determining the delta in power consumed, it is possible for the host to determine the total energy consumed over that period.

## PMBus INTERFACE

The I<sup>2</sup>C bus is a common, simple serial bus used by many devices to communicate. It defines the electrical specifications, the bus timing, the physical layer, and some basic protocol rules.

SMBus is based on I<sup>2</sup>C and aims to provide a more robust and fault tolerant bus. Functions such as bus timeout and packet error checking are added to help achieve this robustness, along with more specific definitions of the bus messages used to read and write data to devices on the bus.

PMBus is layered on top of SMBus and, in turn, on I<sup>2</sup>C. Using the SMBus defined bus messages, PMBus defines a set of standard commands that can be used to control a device that is part of a power chain.

The [ADM1276](#) command set is based upon the *PMBus™ Power System Management Protocol Specification*, Part I and Part II, Revision 1.2. This version of the standard is intended to provide a common set of commands for communicating with dc-to-dc type devices. However, many of the standard PMBus commands can be mapped directly to the functions of a hot swap controller.

Part I and Part II of the PMBus standard describe the basic commands and how they can be used in a typical PMBus setup. The following sections describe how the PMBus standard and the [ADM1276](#) specific commands are used.

### DEVICE ADDRESSING

The [ADM1276](#) is available in one model: the [ADM1276-3](#). The PMBus address is 7 bits in size. The upper 5 bits (MSBs) of the address word are fixed. The base address for the [ADM1276](#) is 01000xx (0x20).

The [ADM1276](#) has a single ADR pin that is used to select one of four possible addresses. The ADR pin connection selects the lowest two bits (LSBs) of the 7-bit address word (see Table 6).

**Table 6. PMBus Addresses and ADR Pin Connection**

| Value of Address LSBs | ADR Pin Connection       |
|-----------------------|--------------------------|
| 00                    | Connect to GND           |
| 01                    | 150 kΩ resistor to GND   |
| 10                    | No connection (floating) |
| 11                    | Connect to VCAP          |

### SMBus PROTOCOL USAGE

All I<sup>2</sup>C transactions on the [ADM1276](#) are done using SMBus defined bus protocols. The following SMBus protocols are implemented by the [ADM1276](#):

- Send byte
- Receive byte
- Write byte
- Read byte
- Write word
- Read word
- Block read

### PACKET ERROR CHECKING

The [ADM1276](#) PMBus interface supports the use of the packet error checking (PEC) byte that is defined in the SMBus standard. The PEC byte is transmitted by the [ADM1276](#) during a read transaction or sent by the bus host to the [ADM1276](#) during a write transaction. The [ADM1276](#) supports the use of PEC with all the SMBus protocols that it implements.

The use of the PEC byte is optional. The bus host can decide whether to use the PEC byte with the [ADM1276](#) on a message-by-message basis. There is no need to enable or disable PEC in the [ADM1276](#).

The PEC byte is used by the bus host or the [ADM1276](#) to detect errors during a bus transaction, depending on whether the transaction is a read or a write. If the host determines that the PEC byte read during a read transaction is incorrect, it can decide to repeat the read if necessary. If the [ADM1276](#) determines that the PEC byte sent during a write transaction is incorrect, it ignores the command (does not execute it) and sets a status flag.

Within a group command, the host can choose to send or not send a PEC byte as part of the message to the [ADM1276](#).

### PARTIAL TRANSACTIONS ON I<sup>2</sup>C BUS

In the event of a specific sequence of events occurring on the I<sup>2</sup>C bus, it is possible for the I<sup>2</sup>C interface on the device to go into a state where it will fail to acknowledge the next I<sup>2</sup>C transaction directed to it. There are two ways that this behavior can be triggered:

- A partial I<sup>2</sup>C transaction consisting of a start condition, followed by a single SCL clock pulse and stop condition.
- If the I<sup>2</sup>C bus master does not follow the 300 ns SDA data hold time when signaling the ACK/NACK bit at the end of a transaction. The device sees this as a single SCL clock partial transaction.

In the event that the device does not acknowledge a transaction, then the I<sup>2</sup>C interface on the device can be reset by sending a series of up to 16 SCL clock pulses, or performing a dummy transaction to another I<sup>2</sup>C address on the bus.

## SMBus MESSAGE FORMATS

Figure 52 to Figure 60 show all the SMBus protocols supported by the ADM1276, along with the PEC variant. In these figures, unshaded cells indicate that the bus host is actively driving the bus; shaded cells indicate that the ADM1276 is driving the bus.

Figure 52 to Figure 60 use the following abbreviations:

S is the start condition.

Sr is the repeated start condition.

P is the stop condition.

R is the read bit.

$\bar{W}$  is the write bit.

$\bar{A}$  is the acknowledge bit (0).

$\bar{A}$  is the acknowledge bit (1).

“A” represents the acknowledge bit. The acknowledge bit is typically active low (Logic 0) if the transmitted byte is successfully received by a device. However, when the receiving device is the bus master, the acknowledge bit for the last byte read is a Logic 1, indicated by  $\bar{A}$ .

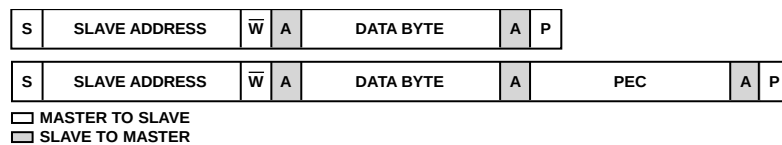


Figure 52. Send Byte and Send Byte with PEC

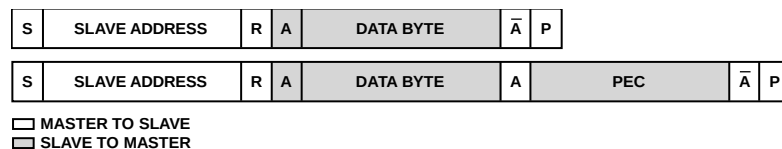


Figure 53. Receive Byte and Receive Byte with PEC

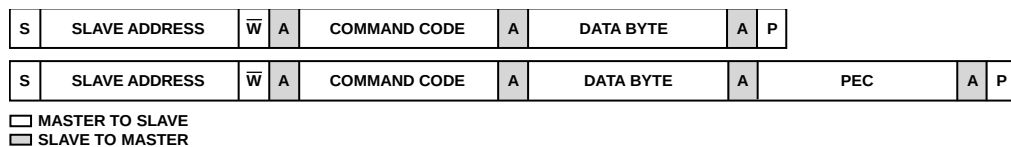


Figure 54. Write Byte and Write Byte with PEC

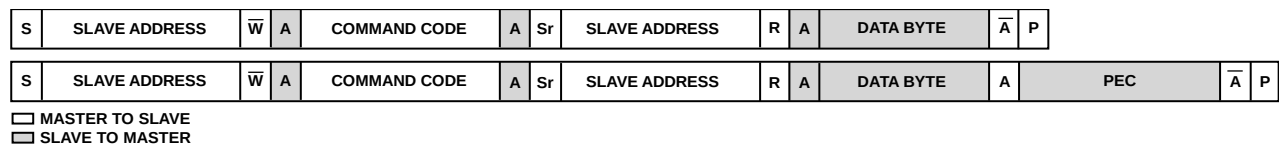


Figure 55. Read Byte and Read Byte with PEC

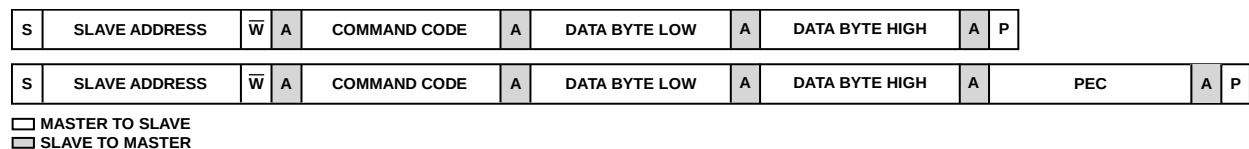


Figure 56. Write Word and Write Word with PEC

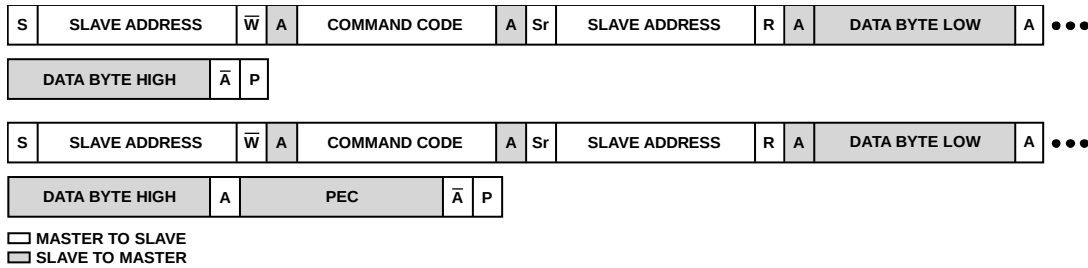


Figure 57. Read Word and Read Word with PEC

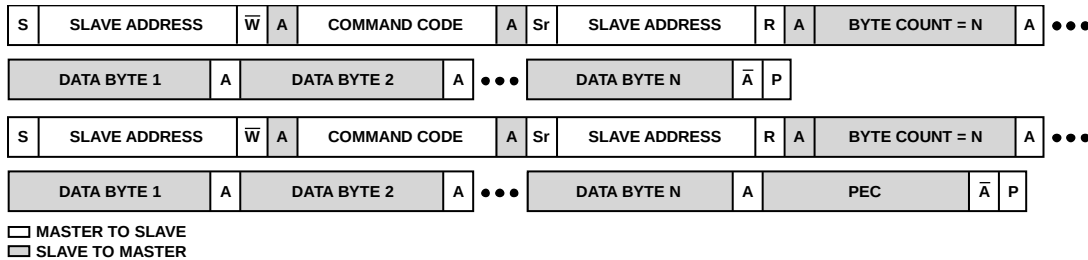


Figure 58. Block Read and Block Read with PEC

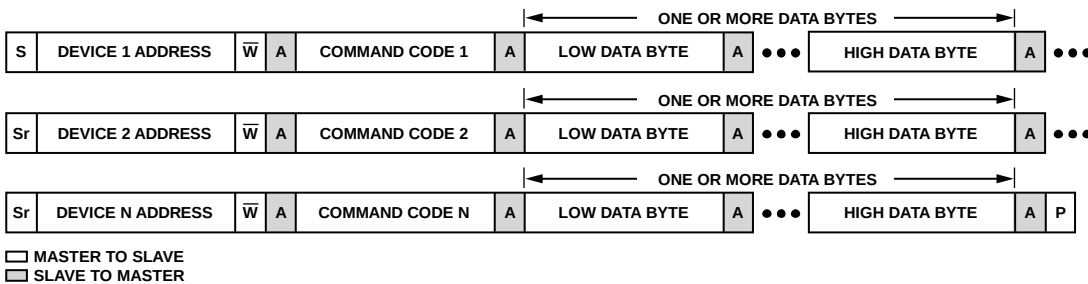


Figure 59. Group Command

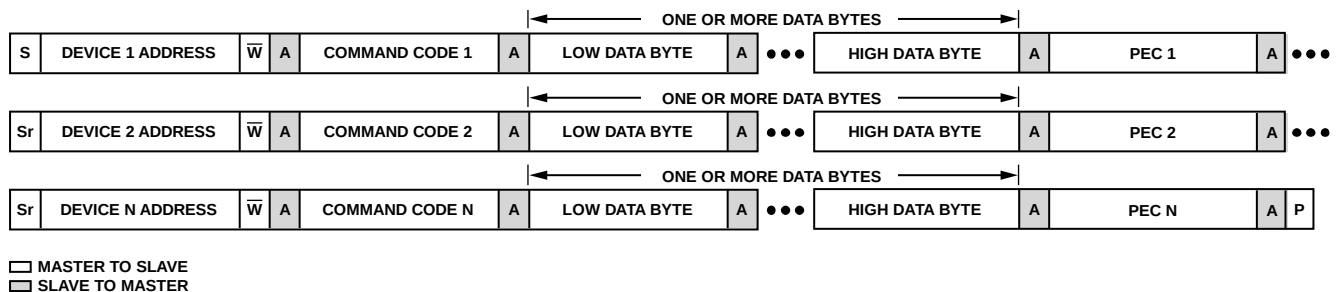


Figure 60. Group Command with PEC

## GROUP COMMANDS

The PMBus standard defines what are known as group commands. Group commands are single bus transactions that send commands or data to more than one device at the same time. Each device is addressed separately, using its own address; there is no special group command address. A group command transaction can contain only write commands that send data to a device. It is not possible to use a group command to read data from devices.

From an I<sup>2</sup>C protocol point of view, a normal write command consists of the following:

- I<sup>2</sup>C start condition.
- Slave address bits and a write bit (followed by an acknowledge from the slave device).
- One or more data bytes (each of which is followed by an acknowledge from the slave device).
- I<sup>2</sup>C stop condition to end the transaction.

A group command differs from a nongroup command in that after the data is written to one slave device, a repeated start condition is placed on the bus followed by the address of the next slave device and data. This continues until all of the devices have been written to, at which point the stop condition is placed on the bus by the master device.

The format of a group command and a group command with PEC is shown in Figure 59 and Figure 60.

Each device that is written to as part of the group command does not immediately execute the command written. The device must wait until the stop condition appears on the bus. At that point, all devices execute their commands at the same time.

Using a group command, it is possible, for example, to turn multiple PMBus devices on or off simultaneously. In the case of the ADM1276, it is also possible to issue a power monitor command that initiates a conversion, causing multiple ADM1276 devices to sample together at the same time.

## HOT SWAP CONTROL COMMANDS

### OPERATION Command

The GATE pin that drives the FET is controlled by a dedicated hot swap state machine. The UV and OV input pins, the TIMER and SS pins, and the current sense all feed into the state machine and they control when and how strongly the gate is turned off.

It is also possible to control the hot swap GATE output using commands over the PMBus interface. The OPERATION command can be used to request the hot swap output to turn on. However, if the UV pin indicates that the input supply is less than required, the hot swap output is not turned on, even if the OPERATION command indicates that the output should be enabled.

If the OPERATION command is used to disable the hot swap output, the GATE pin is held low, even if all hot swap state machine control inputs indicate that it can be enabled.

The default state of Bit 7 (also named the on bit) of the OPERATION command is 1; therefore, the hot swap output is always enabled when the ADM1276 emerges from UVLO. If the on bit is never changed, the UV input or the ENABLE input is the hot swap master on/off control signal.

By default at power-up, the OPERATION command is disabled and must be enabled using the DEVICE\_CONFIG command. This prevents inadvertent shutdowns of the hot swap controller by software.

If the on bit is set to 0 while the UV signal is high, the hot swap output is turned off. If the UV signal is low or if the OV signal is high, the hot swap output is already off and the status of the on bit has no effect.

If the on bit is set to 1, the hot swap output is requested to turn on. If the UV signal is low or if the OV signal is high, setting the on bit to 1 has no effect, and the hot swap output remains off.

It is possible to determine at any time whether the hot swap output is enabled using the STATUS\_BYTE or the STATUS\_WORD command (see the Status Commands section).

The OPERATION command can also clear any latched faults in the status registers. To clear latched faults, set the on bit to 0 and then reset it to 1.

### DEVICE\_CONFIG Command

The DEVICE\_CONFIG command configures certain settings within the ADM1276, for example, enabling or disabling foldback in the hot swap controller, or modifying the duration of the severe overcurrent glitch filter. This command is also used to configure the polarity of the second IOUT current warnings.

The OPERATION command is disabled at power-up. If the OPERATION command is received, the ADM1276 responds with a no acknowledge. To allow use of the OPERATION command, the OPERATION\_CMD\_EN bit must be set via the DEVICE\_CONFIG command.

### POWER\_CYCLE Command

The POWER\_CYCLE command can be used to request that the ADM1276 be turned off for ~4 seconds and then turned back on. This command can be useful if the processor that controls the ADM1276 is also powered off when the ADM1276 is turned off. This command allows the processor to request that the ADM1276 turn off and on again as part of a single command.

## ADM1276 INFORMATION COMMANDS

### CAPABILITY Command

The CAPABILITY command can be used by host processors to determine the I<sup>2</sup>C bus features that are supported by the ADM1276. The features that can be reported include the maximum bus speed, whether the device supports the packet error checking (PEC) byte, and the SMBAlert reporting function.

### PMBUS\_REVISION Command

The PMBUS\_REVISION command reports the version of Part I and Part II of the PMBus standard.

### MFR\_ID, MFR\_MODEL, and MFR\_REVISION Commands

The MFR\_ID, MFR\_MODEL, and MFR\_REVISION commands return ASCII strings that can be used to facilitate detection and identification of the ADM1276 on the bus.

These commands are read using the SMBus block read message type. This message type requires that the ADM1276 return a byte count corresponding to the length of the string data that is to be read back.

## STATUS COMMANDS

The ADM1276 provides a number of status bits that are used to report faults and warnings from the hot swap controller and the power monitor. These status bits are located in six different registers that are arranged in a hierarchy. The STATUS\_BYTE and STATUS\_WORD commands provide 8 bits and 16 bits of high level information, respectively. The STATUS\_BYTE and STATUS\_WORD commands contain the most important status

bits, as well as pointer bits that indicate whether any of the four other status registers need to be read for more detailed status information.

In the [ADM1276](#), a particular distinction is made between faults and warnings. A fault is always generated by the hot swap controller and is defined by hardware component values. Three events can generate a fault:

- Overcurrent condition that causes the hot swap timer to time out.
- Overvoltage condition on the OV pin.
- Undervoltage condition on the UV pin.

When a fault occurs, the hot swap controller always takes some action, usually to turn off the GATE pin, which is driving the FET. A fault can also generate an SMBAlert on the GPO2/ALERT2 pin.

All warnings in the [ADM1276](#) are generated by the power monitor, which samples the voltage and current and then compares these measurements to the threshold values set by the various limit commands. A warning has no effect on the hot swap controller, but it may generate an SMBAlert on the GPO2/ALERT2 output pin.

When a status bit is set, it always means that the status condition—fault or warning—is active or was active at some point in the past. When a fault or warning bit is set, it is latched until it is explicitly cleared using either the OPERATION or the CLEAR\_FAULTS command. Some other status bits are live, that is, they always reflect a status condition and are never latched.

### **STATUS\_BYTE and STATUS\_WORD Commands**

The STATUS\_BYTE and STATUS\_WORD commands can be used to obtain a snapshot of the overall part status. These commands indicate whether it is necessary to read more detailed information using the other status commands.

The low byte of the word returned by the STATUS\_WORD command is the same byte returned by the STATUS\_BYTE command. The high byte of the word returned by the STATUS\_WORD command provides a number of bits that can be used to determine which of the other status commands needs to be issued to obtain all active status bits.

### **STATUS\_INPUT Command**

The STATUS\_INPUT command returns a number of bits relating to voltage faults and warnings on the input supply.

### **STATUS\_VOUT Command**

The STATUS\_VOUT command returns a number of bits relating to voltage faults and warnings on the output supply.

### **STATUS\_IOUT Command**

The STATUS\_IOUT command returns a number of bits relating to current faults and warnings on the output supply.

### **STATUS\_MFR\_SPECIFIC Command**

The STATUS\_MFR\_SPECIFIC command is a standard PMBus command, but the contents of the byte returned are specific to the [ADM1276](#).

### **CLEAR\_FAULTS Command**

The CLEAR\_FAULTS command is used to clear fault and warnings bits when they are set. Fault and warnings bits are latched when they are set. In this way, a host can read the bits any time after the fault or warning condition occurs and determine which problem actually occurred.

If the CLEAR\_FAULTS command is issued and the fault or warning condition is no longer active, the status bit is cleared. If the condition is still active—for example, if an input voltage is below the undervoltage threshold of the UV pin—the CLEAR\_FAULTS command attempts to clear the status bit, but that status bit is immediately set again.

## **GPO AND ALERT PIN SETUP COMMANDS**

A multipurpose pin is provided on the [ADM1276](#): GPO2/ALERT2. The GPO2/ALERT2 pin can be configured over the PMBus in one of three output modes, as follows:

- General-purpose digital output.
- Output for generating an SMBAlert when one or more fault/warning status bits become active in the PMBus status registers.
- Digital comparator.

In digital comparator mode, the current, voltage, and power warning thresholds are compared to the values read or calculated by the [ADM1276](#). The comparison result sets the output high or low according to whether the value is greater or less than the warning threshold that has been set.

For an example of how to configure this pin to generate an SMBAlert and how to respond and clear the condition, see the Example Use of SMBUS Alert Response Address section.

### **ALERT2\_CONFIG Command**

Using combinations of bit masks, the ALERT2\_CONFIG command can be used to select the status bits that, when set, generate an SMBAlert signal to a processor, or control the digital comparator mode. They can also be used to set a GPO mode on the GPO2/ALERT2 pin, so that it is under software control. If this mode is set, the SMBAlert masking bits are ignored.

## **POWER MONITOR COMMANDS**

The [ADM1276](#) provides a high accuracy, 12-bit current and voltage power monitor. The power monitor can be configured in a number of different modes of operation and can run in either continuous mode or single shot mode with a number of different sample averaging options.

The power monitor can measure the following quantities:

- Input voltage (VIN).
- Output voltage (VOUT).
- Output current (IOUT).

The following quantities are then calculated:

- Input power (PIN).
- Input energy (EIN).

### **PMON\_CONFIG Command**

The power monitor can run in a number of different modes with different input voltage range settings. The PMON\_CONFIG command is used to set up the power monitor.

The settings that can be configured are as follows:

- Single shot or continuous sampling.
- VOUT sampling enable/disable.
- Voltage input range.
- Current and voltage sample averaging.

Modifying the power monitor settings while the power monitor is sampling is not recommended. To ensure correct operation of the device and to avoid any potential spurious data or the generation of status alerts, stop the power monitor before any of these settings are changed.

### **PMON\_CONTROL Command**

Power monitor sampling can be initiated via hardware or via software using the PMON\_CONTROL command. This command can be used with single shot or continuous mode.

### **READ\_VIN, READ\_VOUT, and READ\_IOUT Commands**

The [ADM1276](#) power monitor measures the voltage developed across the sense resistor to provide a current measurement. The input voltage from the SENSE+ pin is always measured, and the output voltage present on the VOUT pin is available if enabled with the PMON\_CONFIG command.

### **READ\_PIN, READ\_PIN\_EXT, READ\_EIN, and READ\_EIN\_EXT Commands**

The 12-bit VIN input voltage and 12-bit IOUT current measurement values are multiplied by the [ADM1276](#) to give the input power value. This is accomplished by using fixed point arithmetic, and produces a 24-bit value. It is assumed that the numbers are in the 12.0 format, meaning that there is no fractional part. Note that only positive IOUT values are used to avoid returning a negative power.

This 24-bit value can be read from the [ADM1276](#) using the READ\_PIN\_EXT command, where the most significant bit (MSB) is always a zero because PIN\_EXT is a two's complement binary value that is always positive.

The sixteen most significant bits of the 24-bit value are used as the value for PIN. The MSB of the 16-bit PIN word is always zero, as PIN is a two's complement binary value, that is always positive.

Each time a power calculation is done, the 24-bit power value is added to a 24-bit energy accumulator register. This is a two's complement representation as well, so the MSB is always zero. Each time this energy accumulator register rolls over from 0x7FFFFFFF to 0x000000, a 16-bit rollover counter is incremented. The rollover counter is straight binary, with a maximum value of 0xFFFF before it rolls over.

A 24-bit straight binary power sample counter is also incremented by 1 each time a power value is calculated and added to the energy accumulator.

These registers can be read back using one of two commands, depending on the level of accuracy required for the energy accumulator and the desire to limit the frequency of reads from the [ADM1276](#).

A bus host can read these values, and by calculating the delta in the energy accumulated, the delta in the number of samples, and the time delta since the last read, the host can calculate the average power since the last read, as well as the energy consumed since then.

The time delta is calculated by the bus host based on when it sends its commands to read from the device, and is not provided by the [ADM1276](#).

To avoid loss of data, the bus host must read at a rate that ensures the rollover counter does not wrap around more than once, and if the counter does wrap around that the next value read for PIN is less than the previous one.

The READ\_EIN command returns the top 16 bits of the energy accumulator, the lower eight bits of the rollover counter, and the full 24 bits of the sample counter.

The READ\_EIN\_EXT command returns the full 24 bits of the energy accumulator, the full 16 bits of the rollover counter, and the full 24 bits of the sample counter. The use of the longer rollover counter means that the time interval between reads of the part can be increased from seconds to minutes, without losing any data.

### **PEAK\_IOUT, PEAK\_VIN, PEAK\_VOUT, and PEAK\_PIN Commands**

In addition to the standard PMBus commands for reading voltage and current, the [ADM1276](#) provides commands that can report the maximum peak voltage, current, or power value since the peak value was last cleared.

The peak values are updated only after the power monitor has sampled and averaged the current and voltage measurements. Individual peak values are cleared by writing a 0 value with the corresponding command.

### **WARNING LIMIT SETUP COMMANDS**

The [ADM1276](#) power monitor can monitor a number of different warning conditions simultaneously and report any current or voltage values that exceed the user-defined thresholds using the status commands.

All comparisons performed by the power monitor require the measured value to be strictly greater or less than the threshold value.

At power-up, all threshold limits are set to either minimum scale (for undervoltage or undercurrent conditions) or to maximum scale (for overvoltage or overcurrent or overpower conditions). This effectively disables the generation of any status warnings by default; warning bits are not set in the status registers until the user explicitly sets the threshold values.

#### **VIN\_OV\_WARN\_LIMIT and VIN\_UV\_WARN\_LIMIT Commands**

The VIN\_OV\_WARN\_LIMIT and VIN\_UV\_WARN\_LIMIT commands are used to set the OV and UV thresholds on the input voltage, as measured at the SENSE+ pin.

#### **VOUT\_OV\_WARN\_LIMIT and VOUT\_UV\_WARN\_LIMIT Commands**

The VOUT\_OV\_WARN\_LIMIT and VOUT\_UV\_WARN\_LIMIT commands are used to set the OV and UV thresholds on the output voltage, as measured at the VOUT pin.

#### **IOUT\_OC\_WARN\_LIMIT Command**

The IOUT\_OC\_WARN\_LIMIT command sets the OC threshold for the current flowing through the sense resistor.

#### **IOUT\_WARN2\_LIMIT Command**

The IOUT\_WARN2\_LIMIT command provides a second current warning threshold that can be programmed. The polarity of this warning can be set to overcurrent or undercurrent using the DEVICE\_CONFIG command.

#### **PIN\_OP\_WARN\_LIMIT Command**

The PIN\_OP\_WARN\_LIMIT command is used to set the overpower threshold for the power delivered to the load.

### **PMBus DIRECT FORMAT CONVERSION**

The ADM1276 uses the PMBus direct format to represent real-world quantities such as voltage, current, and power values. A direct format number takes the form of a 2-byte, twos complement, binary integer value.

It is possible to convert between direct format value and real-world quantities using the following equations. Equation 1 converts from real-world quantities to PMBus direct values, and Equation 2 converts PMBus direct format values to real-world values.

$$Y = (mX + b) \times 10^R \quad (1)$$

$$X = 1/m \times (Y \times 10^{-R} - b) \quad (2)$$

where:

$Y$  is the value in PMBus direct format.

$X$  is the real-world value.

$m$  is the slope coefficient, a 2-byte, twos complement integer.

$b$  is the offset, a 2-byte, twos complement integer.

$R$  is a scaling exponent, a 1-byte, twos complement integer.

The same equations are used for voltage, current, and power conversions, the only difference being the values of the  $m$ ,  $b$ , and  $R$  coefficients that are used.

Table 7 lists all the coefficients required for the ADM1276. The current and power coefficients shown are dependent on the value of the external sense resistor used in a given application. This means that an additional calculation must be performed to take the sense resistor value into account to obtain the coefficients for a specific sense resistor value.

The sense resistor value used in the calculations to obtain the coefficients is expressed in milliohms. The  $m$  coefficients are defined as 2-byte twos complement numbers in the PMBus standard, therefore the maximum positive value that can be represented is 32,767. If the  $m$  value is greater than that, and is to be stored in PMBus standard form, then the  $m$  coefficients should be divided by 10, and the  $R$  coefficient increased by a value of 1. For example, if on the 20 V range, a 10 milliohm sense resistor is used, the  $m$  coefficient is 6043, and the  $R$  coefficient is  $-1$ .

Example 1: IOUT\_OC\_WARN\_LIMIT requires a current-limit value expressed in direct format.

If the required current limit is 10 A, and the sense resistor is 2 mΩ, then the first step is to determine the voltage coefficient. This is simply  $m = 807 \times 2$ , giving 1614.

Using Equation 1, and expressing  $X$ , in units of Amps

$$Y = ((1614 \times 10) + 20,475) \times 10^{-1}$$

$$Y = 3661.5 = 3662 \text{ (rounded up to integer form)}$$

Writing a value of 3662 with the IOUT\_OC\_WARN\_LIMIT command sets an overcurrent warning at 10 A.

Example 2: The READ\_IOUT command returns a direct format value of 3339 representing the current flowing through a sense resistor of 1 mΩ.

To convert this value to the current flowing, use Equation 2, with  $m = 807 \times 1$ .

$$X = 1/807 \times (3339 \times 10^1 - 20,475)$$

$$X = 16.00 \text{ A}$$

This means that when READ\_IOUT returns a value of 3339, 16.00 A is flowing in the sense resistor.

There are two input voltage ranges, so there are also two sets of coefficients for converting to and from the power value, depending on which voltage range is selected.

Note the following:

- The same calculations that are used to convert power values also apply to the energy accumulator value returned by the READ\_EIN command because the energy accumulator is a summation of multiple power values.
- The READ\_PIN\_EXT and READ\_EIN\_EXT commands return 24-bit extended precision versions of the 16-bit values returned by READ\_PIN and READ\_EIN. The direct

format values must be divided by 256 prior to being converted with the coefficients shown in Table 7.

Example 3: The PIN\_OP\_WARN\_LIMIT command requires a power limit value expressed in direct format.

If the required power limit is 350 W and the sense resistor is 1 mΩ, the first step is to determine the m coefficient. Assuming the 0 V to 20 V range,  $m = 6043 \times 1$ , which is 6043.

Using Equation 1, and working with the 0 V to 20 V range,

$$Y = ((6043 \times 350) \times 10^{-2})$$

$$Y = 21,150.5 = 21,151 \text{ (rounded up to integer form)}$$

Writing a value of 21,151 with the PIN\_OP\_WARN\_LIMIT command sets an overpower warning at 350 W.

**Table 7. PMBus Conversion to Real-World Coefficients**

| Coefficient | Current (A)                   | Voltage (V)      |                   | Power (W)                      |                                |
|-------------|-------------------------------|------------------|-------------------|--------------------------------|--------------------------------|
|             |                               | 0 V to 6 V Range | 0 V to 20 V Range | 0 V to 6 V Range               | 0 V to 20 V Range              |
| m           | $807 \times R_{\text{SENSE}}$ | 6720             | 19,199            | $2115 \times R_{\text{SENSE}}$ | $6043 \times R_{\text{SENSE}}$ |
| b           | 20,475                        | 0                | 0                 | 0                              | 0                              |
| R           | −1                            | −1               | −2                | −1                             | −2                             |

## VOLTAGE AND CURRENT CONVERSION USING LSB VALUES

The direct format voltage and current values returned by the READ\_VIN, READ\_VOUT, and READ\_IOUT commands, and the corresponding peak versions, are the data output directly by the ADM1276 ADC. Because the voltages and currents are 12-bit ADC output codes, they can also be converted to real-world values when there is knowledge of the size of the LSB on the ADC.

The m, b, and R coefficients defined for the PMBus conversion are required to be whole integers by the standard and have, therefore, been rounded slightly. Using this alternative method, with the exact LSB values, can provide somewhat more accurate numerical conversions.

To convert an ADC code to current in amperes, the following formulas can be used:

$$V_{SENSE} = LSB_{25\text{ mV}} \times (I_{ADC} - 2048)$$

$$I_{OUT} = V_{SENSE} / (R_{SENSE} \times 0.001)$$

where:

$$V_{SENSE} = (V_{SENSE+}) - (V_{SENSE-}).$$

$$LSB_{25\text{ mV}} = 12.4\text{ }\mu\text{V}.$$

$I_{ADC}$  is the 12-bit ADC code.

$I_{OUT}$  is the measured current value in amperes.

$R_{SENSE}$  is the value of the sense resistor in milliohms.

To convert an ADC code to a voltage, the following formula can be used:

$$V_M = LSB_{xV} \times (V_{ADC} + 0.5)$$

where:

$V_M$  is the measured value in volts.

$V_{ADC}$  is the 12-bit ADC code.

$LSB_{xV}$  values are based on the voltage range (see Table 8).

**Table 8. Voltage Ranges and LSB Values**

| Voltage Range, $LSB_{xV}$ | LSB Magnitude |
|---------------------------|---------------|
| 0 V to 6 V                | 1.488 mV      |
| 0 V to 20 V               | 5.208 mV      |

To convert a current in amperes to a 12-bit value, the following formula can be used (round the result to the nearest integer):

$$V_{SENSE} = I_A \times R_{SENSE} \times 0.001$$

$$I_{CODE} = 2048 + (V_{SENSE} / LSB_{25\text{ mV}})$$

where:

$$V_{SENSE} = (V_{SENSE+}) - (V_{SENSE-}).$$

$I_A$  is the current value in amperes.

$R_{SENSE}$  is the value of the sense resistor in milliohms.

$I_{CODE}$  is the 12-bit ADC code.

$$LSB_{25\text{ mV}} = 12.4\text{ }\mu\text{V}.$$

To convert a voltage to a 12-bit value, the following formula can be used (round the result to the nearest integer):

$$V_{CODE} = (V_A / LSB_{xV}) - 0.5$$

where:

$V_{CODE}$  is the 12-bit ADC code.

$V_A$  is the voltage value in volts.

$LSB_{xV}$  values are based on the voltage range (see Table 8).

## GPO2/ALERT2 PIN BEHAVIOR

The [ADM1276](#) provides a very flexible alert system, whereby one or more fault/warning conditions can be indicated to an external device.

### FAULTS AND WARNINGS

A PMBus fault on the [ADM1276](#) is always generated due to an analog event and causes a change in state in the hot swap output, turning it off. The three defined fault sources are as follows:

- Undervoltage (UV) event detected on the UV pin.
- Overvoltage (OV) event detected on the OV pin.
- Overcurrent (OC) event that causes a hot swap timeout.

Faults are continuously monitored, and, as long as power is applied to the device, they cannot be disabled. When a fault occurs, a corresponding status bit is set in one or more STATUS\_XXX registers.

A value of 1 in a status register bit field always indicates a fault or warning condition. Fault and warning bits in the status registers are latched when set to 1. To clear a latched bit to 0—provided that the fault condition is no longer active—use the CLEAR\_FAULTS command or use the OPERATION command to turn the hot swap output off and then on again.

A warning is less severe than a fault and never causes a change in the state of the hot swap controller. The sources of a warning are defined as follows:

- CML: a communications error occurred on the I<sup>2</sup>C bus.
- HS timer was active (HSTA): the current regulation was active, but did not necessarily shut the system down.
- IOUT OC warning from the ADC.
- IOUT Warning 2 from the ADC.
- VIN UV warning from the ADC.
- VIN OV warning from the ADC.
- VOUT UV warning from the ADC.
- VOUT OV warning from the ADC.
- PIN OP warning from the VIN × IOUT calculation.

### GENERATING AN ALERT

A host device can periodically poll the [ADM1276](#) using the status commands to determine whether a fault/warning is active. However, this polling is very inefficient in terms of software and processor resources. The [ADM1276](#) has a GPO2/ALERT2 output pin that can be used to generate interrupts to a host processor.

By default at power-up, the open-drain GPO2/ALERT2 output is high impedance, so the pin can be pulled high through a resistor. The FET health bad warning is active by default on the GPO2/ALERT2 pin at power-up.

Any one or more of the faults and warnings listed in the Faults and Warnings section can be enabled and cause an alert, making

the GPO2/ALERT2 pin active. By default, the active state of the GPO2/ALERT2 pin is low.

For example, to use GPO2/ALERT2 to monitor the VOUT UV warning from the ADC, the followings steps must be performed:

1. Set a threshold level with the VOUT\_UV\_WARN\_LIMIT command.
2. Start the power monitor sampling on VOUT.

If a VOUT sample is taken that is below the configured VOUT UV value, the GPO2/ALERT2 pin is taken low, signaling an interrupt to a processor.

### HANDLING/CLEARING AN ALERT

When faults/warnings are configured on the GPO2/ALERT2 pin, the pin becomes active to signal an interrupt to the processor. (The pin is active low, unless inversion is enabled.) The ALERT2 signal on the GPO2/ALERT2 pin functions as an SMBAlert.

A processor can respond to the interrupt in one of two basic ways:

- If there is only one device on the bus, the processor can simply read the status bytes and issue a CLEAR\_FAULTS command to clear all the status bits, which causes the deassertion of the GPO2/ALERT2 line. If there is a persistent fault—for example, an undervoltage on the input—the status bits remain set after the CLEAR\_FAULTS command is executed because the fault has not been removed. However, the GPO2/ALERT2 line is not pulled low unless a new fault or warning becomes active. If the cause of the SMBAlert is a power monitor generated warning and the power monitor is running continuously, the next sample generates a new SMBAlert after the CLEAR\_FAULTS command is issued.
- If there are several devices on the bus, the processor can issue an SMBus alert response address command to find out which device asserted the SMBAlert line. The processor can read the status bytes from that device and issue a CLEAR\_FAULTS command.

### SMBus ALERT RESPONSE ADDRESS

The SMBus alert response address (ARA) is a special address that can be used by the bus host to locate any devices that need to talk to it. A host typically uses a hardware interrupt pin to monitor the SMBus alert pins of a number of devices. When the host interrupt occurs, the host issues a message on the bus using the SMBus receive byte or receive byte with PEC protocol.

The special address used by the host is 0x0C. Any devices that have an SMBAlert signal return their own 7-bit address as the seven MSBs of the data byte. The LSB value is not used and can be either 1 or 0. The host reads the device address from the received data byte and proceeds to handle the alert condition.

More than one device may have an active SMBAlert signal and attempt to communicate with the host. In this case, the device with the lowest address dominates the bus and succeeds in transmitting its address to the host. The device that succeeds disables its SMBus alert signal. If the host sees that the SMBus alert signal is still low, it continues to read addresses until all devices that need to talk to it have successfully transmitted their addresses.

### EXAMPLE USE OF SMBus ALERT RESPONSE ADDRESS

The full sequence of steps that occurs when an SMBAlert is generated and cleared is as follows:

1. A fault or warning is enabled using the ALERT2\_CONFIG command, and the corresponding status bit for the fault or warning changes from 0 to 1, indicating that the fault or warning has just become active.
2. The GPO2/ALERT2 pin becomes active (low) to signal that an SMBAlert is active.
3. The host processor issues an SMBus alert response address command to determine which device has an active alert.
4. If there are no other active alerts from devices with lower I<sup>2</sup>C addresses, this device makes the GPO2/ALERT2 pin inactive (high) during the no acknowledge bit period after it sends its address to the host processor.
5. If the GPO2/ALERT2 pin stays low, the host processor must continue to issue SMBus alert response address commands to devices to find out the addresses of all devices whose status it must check.
6. The ADM1276 continues to operate with the GPO2/ALERT2 pin inactive and the contents of the status bytes unchanged until the host reads the status bytes and clears them, or until a new fault occurs. That is, if a status bit for a fault/warning that is enabled on the GPO2/ALERT2 pin and that was not already active (equal to 1) changes from 0 to 1, a new alert is generated, causing the GPO2/ALERT2 pin to become active again.

## PMBus COMMAND REFERENCE

Command codes are in hexadecimal format.

Table 9. PMBus Command Summary

| Command Code | Command Name        | SMBus Transaction Type | Number of Data Bytes      | Default Value at Reset           |
|--------------|---------------------|------------------------|---------------------------|----------------------------------|
| 0x01         | OPERATION           | Read/write byte        | 1                         | 0x80                             |
| 0x03         | CLEAR_FAULTS        | Send byte              | 0                         | Not applicable                   |
| 0x19         | CAPABILITY          | Read byte              | 1                         | 0xB0                             |
| 0x42         | VOUT_OV_WARN_LIMIT  | Read/write word        | 2                         | 0x0FFF                           |
| 0x43         | VOUT_UV_WARN_LIMIT  | Read/write word        | 2                         | 0x0000                           |
| 0x4A         | IOUT_OC_WARN_LIMIT  | Read/write word        | 2                         | 0x0FFF                           |
| 0x57         | VIN_OV_WARN_LIMIT   | Read/write word        | 2                         | 0x0FFF                           |
| 0x58         | VIN_UV_WARN_LIMIT   | Read/write word        | 2                         | 0x0000                           |
| 0x6B         | PIN_OP_WARN_LIMIT   | Read/write word        | 2                         | 0x7FFF                           |
| 0x78         | STATUS_BYTE         | Read byte              | 1                         | 0x00                             |
| 0x79         | STATUS_WORD         | Read word              | 2                         | 0x0000                           |
| 0x7A         | STATUS_VOUT         | Read byte              | 1                         | 0x00                             |
| 0x7B         | STATUS_IOUT         | Read byte              | 1                         | 0x00                             |
| 0x7C         | STATUS_INPUT        | Read byte              | 1                         | 0x00                             |
| 0x80         | STATUS_MFR_SPECIFIC | Read byte              | 1                         | 0x00                             |
| 0x86         | READ_EIN            | Block read             | 1 (byte count) + 6 (data) | 0x06, 0x0000, 0x00, 0x000000     |
| 0x88         | READ_VIN            | Read word              | 2                         | 0x0000                           |
| 0x8B         | READ_VOUT           | Read word              | 2                         | 0x0000                           |
| 0x8C         | READ_IOUT           | Read word              | 2                         | 0x0000                           |
| 0x97         | READ_PIN            | Read word              | 2                         | 0x0000                           |
| 0x98         | PMBUS_REVISION      | Read byte              | 1                         | 0x22                             |
| 0x99         | MFR_ID              | Block read             | 1 (byte count) + 3 (data) | 0x03 + ASCII "ADI"               |
| 0x9A         | MFR_MODEL           | Block read             | 1 (byte count) + 9 (data) | 0x09 + ASCII "ADM1276-3"         |
| 0x9B         | MFR_REVISION        | Block read             | 1 (byte count) + 1 (data) | 0x01 + ASCII "0"                 |
| 0xD0         | PEAK_IOUT           | Read/write word        | 2                         | 0x0000                           |
| 0xD1         | PEAK_VIN            | Read/write word        | 2                         | 0x0000                           |
| 0xD2         | PEAK_VOUT           | Read/write word        | 2                         | 0x0000                           |
| 0xD3         | PMON_CONTROL        | Read/write byte        | 1                         | 0x01                             |
| 0xD4         | PMON_CONFIG         | Read/write byte        | 1                         | 0xAF                             |
| 0xD6         | ALERT2_CONFIG       | Read/write word        | 2                         | 0x8000                           |
| 0xD7         | IOUT_WARN2_LIMIT    | Read/write word        | 2                         | 0x0000                           |
| 0xD8         | DEVICE_CONFIG       | Read/write byte        | 1                         | 0x00                             |
| 0xD9         | POWER_CYCLE         | Send byte              | 0                         | Not applicable                   |
| 0xDA         | PEAK_PIN            | Read/write word        | 2                         | 0x0000                           |
| 0xDB         | READ_PIN_EXT        | Block read             | 1 (byte count) + 3 (data) | 0x03, 0x000000                   |
| 0xDC         | READ_EIN_EXT        | Block read             | 1 (byte count) + 8 (data) | 0x08, 0x000000, 0x0000, 0x000000 |

**OPERATION**

Code: 0x01, read/write byte. Value after reset: 0x80.

**Table 10. Bit Descriptions for OPERATION Command**

| Bits  | Bit Name | Settings | Description                          |
|-------|----------|----------|--------------------------------------|
| [7]   | On       | 0        | Hot swap output is disabled.         |
|       |          | 1        | Default. Hot swap output is enabled. |
| [6:0] | Reserved | 0000000  | Always reads as 0000000.             |

**CLEAR\_FAULTS**

Code: 0x03, send byte, no data.

**CAPABILITY**

Code: 0x19, read byte. Value after reset: 0xB0.

**Table 11. Bit Descriptions for CAPABILITY Command**

| Bits  | Bit Name              | Settings | Description                                                                   |
|-------|-----------------------|----------|-------------------------------------------------------------------------------|
| [7]   | Packet error checking | 1        | Always reads as 1. Packet error checking (PEC) is supported.                  |
| [6:5] | Maximum bus speed     | 01       | Always reads as 01. Maximum supported bus speed is 400 kHz.                   |
| [4]   | SMBALERT#             | 1        | Always reads as 1. Device supports SMBAlert and alert response address (ARA). |
| [3:0] | Reserved              | 0000     | Always reads as 0000.                                                         |

**VOUT\_OV\_WARN\_LIMIT**

Code: 0x42, read/write word. Value after reset: 0x0FFF.

**Table 12. Bit Descriptions for VOUT\_OV\_WARN\_LIMIT Command**

| Bits    | Bit Name           | Settings | Description                                                                 |
|---------|--------------------|----------|-----------------------------------------------------------------------------|
| [15:12] | Reserved           | 0000     | Always reads as 0000.                                                       |
| [11:0]  | VOUT_OV_WARN_LIMIT |          | Overvoltage threshold for the VOUT pin measurement, expressed in ADC codes. |

**VOUT\_UV\_WARN\_LIMIT**

Code: 0x43, read/write word. Value after reset: 0x0000.

**Table 13. Bit Descriptions for VOUT\_UV\_WARN\_LIMIT Command**

| Bits    | Bit Name           | Settings | Description                                                                  |
|---------|--------------------|----------|------------------------------------------------------------------------------|
| [15:12] | Reserved           | 0000     | Always reads as 0000.                                                        |
| [11:0]  | VOUT_UV_WARN_LIMIT |          | Undervoltage threshold for the VOUT pin measurement, expressed in ADC codes. |

**IOUT\_OC\_WARN\_LIMIT**

Code: 0x4A, read/write word. Value after reset: 0x0FFF.

**Table 14. Bit Descriptions for IOUT\_OC\_WARN\_LIMIT Command**

| Bits    | Bit Name           | Settings | Description                                                                                        |
|---------|--------------------|----------|----------------------------------------------------------------------------------------------------|
| [15:12] | Reserved           | 0000     | Always reads as 0000.                                                                              |
| [11:0]  | IOUT_OC_WARN_LIMIT |          | Overcurrent threshold for the IOUT measurement through the sense resistor, expressed in ADC codes. |

**IOUT\_WARN2\_LIMIT**

Code: 0xD7, read/write word. Value after reset: 0x0000.

**Table 15. Bit Descriptions for IOUT\_WARN2\_LIMIT Command**

| Bits    | Bit Name         | Settings | Description                                                                                                                                                                                                                                         |
|---------|------------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [15:12] | Reserved         | 0000     | Always reads as 0000.                                                                                                                                                                                                                               |
| [11:0]  | IOUT_WARN2_LIMIT |          | Threshold for the IOUT measurement through the sense resistor, expressed in ADC codes. This value can be either an undercurrent or an overcurrent, depending on the state of the IOUT_WARN2_SELECT bit that is set using the DEVICE_CONFIG command. |

**VIN\_OV\_WARN\_LIMIT**

Code: 0x57, read/write word. Value after reset: 0x0FFF.

**Table 16. Bit Descriptions for VIN\_OV\_WARN\_LIMIT Command**

| Bits    | Bit Name          | Settings | Description                                                                   |
|---------|-------------------|----------|-------------------------------------------------------------------------------|
| [15:12] | Reserved          | 0000     | Always reads as 0000.                                                         |
| [11:0]  | VIN_OV_WARN_LIMIT |          | Overvoltage threshold for the SENSE+ pin measurement, expressed in ADC codes. |

**VIN\_UV\_WARN\_LIMIT**

Code: 0x58, read/write word. Value after reset: 0x0000.

**Table 17. Bit Descriptions for VIN\_UV\_WARN\_LIMIT Command**

| Bits    | Bit Name          | Settings | Description                                                                    |
|---------|-------------------|----------|--------------------------------------------------------------------------------|
| [15:12] | Reserved          | 0000     | Always reads as 0000.                                                          |
| [11:0]  | VIN_UV_WARN_LIMIT |          | Undervoltage threshold for the SENSE+ pin measurement, expressed in ADC codes. |

**PIN\_OP\_WARN\_LIMIT**

Code: 0x6B, read/write word. Value after reset: 0x7FFF.

**Table 18. Bit Descriptions for PIN\_OP\_WARN\_LIMIT Command**

| Bits   | Bit Name          | Settings | Description                                               |
|--------|-------------------|----------|-----------------------------------------------------------|
| [15]   | Reserved          | 0        | Always reads as 0.                                        |
| [14:0] | PIN_OP_WARN_LIMIT |          | Overpower threshold for the VIN × IOUT power calculation. |

**STATUS\_BYTE**

Code: 0x78, read byte. Value after reset: 0x00.

**Table 19. Bit Descriptions for STATUS\_BYTE Command**

| Bits | Bit Name          | Behavior | Settings | Description                                                                                                                                                                                                                                                                                                                                 |
|------|-------------------|----------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7]  | Reserved          |          | 0        | Always reads as 0.                                                                                                                                                                                                                                                                                                                          |
| [6]  | HOTSWAP_OFF       | Live     | 0<br>1   | The hot swap gate drive output is enabled.<br>The hot swap gate drive output is disabled, and the GATE pin is pulled down. This can be due to, for example, an overcurrent fault that causes the <a href="#">ADM1276</a> to latch off, an undervoltage condition on the UV pin, or the use of the OPERATION command to turn the output off. |
| [5]  | Reserved          |          | 0        | Always reads as 0.                                                                                                                                                                                                                                                                                                                          |
| [4]  | IOUT_OC_FAULT     | Latched  | 0<br>1   | No overcurrent output fault detected.<br>The hot swap controller detected an overcurrent condition and the time limit set by the capacitor on the TIMER pin has elapsed, causing the hot swap gate drive to shut down.                                                                                                                      |
| [3]  | VIN_UV_FAULT      | Latched  | 0<br>1   | No undervoltage input fault detected on the UV pin.<br>An undervoltage input fault was detected on the UV pin.                                                                                                                                                                                                                              |
| [2]  | Reserved          |          | 0        | Always reads as 0.                                                                                                                                                                                                                                                                                                                          |
| [1]  | CML_ERROR         | Latched  | 0<br>1   | No communications error detected on the I <sup>2</sup> C/PMBus interface.<br>An error was detected on the I <sup>2</sup> C/PMBus interface. Errors detected are an unsupported command, an invalid PEC byte, and an incorrectly structured message.                                                                                         |
| [0]  | NONE_OF_THE_ABOVE | Live     | 0<br>1   | No other active status bit to be reported by any other status command.<br>Active status bits are waiting to be read by one or more status commands.                                                                                                                                                                                         |

**STATUS\_WORD**

Code: 0x79, read word. Value after reset: 0x0000.

**Table 20. Bit Descriptions for STATUS\_WORD Command**

| Bits   | Bit Name     | Behavior | Settings | Description                                                                                                                                                                  |
|--------|--------------|----------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [15]   | VOUT_STATUS  | Live     | 0        | There are no active status bits to be read by STATUS_VOUT.                                                                                                                   |
|        |              |          | 1        | There are one or more active status bits to be read by STATUS_VOUT.                                                                                                          |
| [14]   | IOUT_STATUS  | Live     | 0        | There are no active status bits to be read by STATUS_IOUT.                                                                                                                   |
|        |              |          | 1        | There are one or more active status bits to be read by STATUS_IOUT.                                                                                                          |
| [13]   | INPUT_STATUS | Live     | 0        | There are no active status bits to be read by STATUS_INPUT.                                                                                                                  |
|        |              |          | 1        | There are one or more active status bits to be read by STATUS_INPUT.                                                                                                         |
| [12]   | MFR_STATUS   | Live     | 0        | There are no active status bits to be read by STATUS_MFR_SPECIFIC.                                                                                                           |
|        |              |          | 1        | There are one or more active status bits to be read by STATUS_MFR_SPECIFIC.                                                                                                  |
| [11]   | POWER_GOOD#  | Live     | 0        | The voltage on the FLB pin is above the required threshold, indicating that output power is considered good. This bit is the logical inversion of the PWRGD pin on the part. |
|        |              |          | 1        | The voltage on the FLB pin is below the required threshold, indicating that output power is considered bad.                                                                  |
| [10:8] | Reserved     |          | 000      | Always reads as 000.                                                                                                                                                         |
| [7:0]  | STATUS_BYTE  |          |          | This byte is the same as the byte returned by the STATUS_BYTE command.                                                                                                       |

**STATUS\_VOUT**

Code: 0x7A, read byte. Value after reset: 0x00.

**Table 21. Bit Descriptions for STATUS\_VOUT Command**

| Bits  | Bit Name     | Behavior | Settings | Description                                                                       |
|-------|--------------|----------|----------|-----------------------------------------------------------------------------------|
| [7]   | Reserved     |          | 0        | Always reads as 0.                                                                |
| [6]   | VOUT_OV_WARN | Latched  | 0        | No overvoltage condition on the output supply detected by the power monitor.      |
|       |              |          | 1        | An overvoltage condition on the output supply was detected by the power monitor.  |
| [5]   | VOUT_UV_WARN | Latched  | 0        | No undervoltage condition on the output supply detected by the power monitor.     |
|       |              |          | 1        | An undervoltage condition on the output supply was detected by the power monitor. |
| [4:0] | Reserved     |          | 00000    | Always reads as 00000.                                                            |

**STATUS\_IOUT**

Code: 0x7B, read byte. Value after reset: 0x00.

**Table 22. Bit Descriptions for STATUS\_IOUT Command**

| Bits  | Bit Name      | Behavior | Settings | Description                                                                                                                                                                   |
|-------|---------------|----------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7]   | IOUT_OC_FAULT | Latched  | 0        | No overcurrent output fault detected.                                                                                                                                         |
|       |               |          | 1        | The hot swap controller detected an overcurrent condition and the time limit set by the capacitor on the TIMER pin has elapsed, causing the hot swap gate drive to shut down. |
| [6]   | Reserved      |          | 0        | Always reads as 0.                                                                                                                                                            |
| [5]   | IOUT_OC_WARN  | Latched  | 0        | No overcurrent condition on the output supply detected by the power monitor using the IOUT_OC_WARN_LIMIT command.                                                             |
|       |               |          | 1        | An overcurrent condition was detected by the power monitor using the IOUT_OC_WARN_LIMIT command.                                                                              |
| [4:0] | Reserved      |          | 00000    | Always reads as 00000.                                                                                                                                                        |

**STATUS\_INPUT**

Code: 0x7C, read byte. Value after reset: 0x00.

**Table 23. Bit Descriptions for STATUS\_INPUT Command**

| Bits  | Bit Name     | Behavior | Settings | Description                                                                      |
|-------|--------------|----------|----------|----------------------------------------------------------------------------------|
| [7]   | VIN_OV_FAULT | Latched  | 0        | No overvoltage detected on the OV pin.                                           |
|       |              |          | 1        | An overvoltage was detected on the OV pin.                                       |
| [6]   | VIN_OV_WARN  | Latched  | 0        | No overvoltage condition on the input supply detected by the power monitor.      |
|       |              |          | 1        | An overvoltage condition on the input supply was detected by the power monitor.  |
| [5]   | VIN_UV_WARN  | Latched  | 0        | No undervoltage condition on the input supply detected by the power monitor.     |
|       |              |          | 1        | An undervoltage condition on the input supply was detected by the power monitor. |
| [4]   | VIN_UV_FAULT | Latched  | 0        | No undervoltage detected on the UV pin.                                          |
|       |              |          | 1        | An undervoltage was detected on the UV pin.                                      |
| [3:1] | Reserved     |          | 000      | Always reads as 000.                                                             |
| [0]   | PIN_OP_WARN  | Latched  | 0        | No overpower condition on the input supply detected by the power monitor.        |
|       |              |          | 1        | An overpower condition on the input supply was detected by the power monitor.    |

**STATUS\_MFR\_SPECIFIC**

Code: 0x80, read byte. Value after reset: 0x00.

**Table 24. Bit Descriptions for STATUS\_MFR\_SPECIFIC Command**

| Bits  | Bit Name          | Behavior | Settings | Description                                                                                                                                                                                                                                                                    |
|-------|-------------------|----------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7]   | FET_HEALTH_BAD    | Latched  | 0        | FET behavior appears to be as expected.                                                                                                                                                                                                                                        |
|       |                   |          | 1        | FET behavior suggests that the FET may be shorted.                                                                                                                                                                                                                             |
| [6]   | UV_CMP_OUT        | Live     | 0        | Input voltage to UV pin is above threshold.                                                                                                                                                                                                                                    |
|       |                   |          | 1        | Input voltage to UV pin is below threshold.                                                                                                                                                                                                                                    |
| [5]   | OV_CMP_OUT        | Live     | 0        | Input voltage to OV pin is below threshold.                                                                                                                                                                                                                                    |
|       |                   |          | 1        | Input voltage to OV pin is above threshold.                                                                                                                                                                                                                                    |
| [4]   | Reserved          |          | 0        | Always reads as 0.                                                                                                                                                                                                                                                             |
| [3]   | HS_INLIM          | Latched  | 0        | The <a href="#">ADM1276</a> has not actively limited the current into the load.                                                                                                                                                                                                |
|       |                   |          | 1        | The <a href="#">ADM1276</a> has actively limited current into the load. This bit differs from the IOUT_OC_FAULT bit in that the HS_INLIM bit is set immediately, whereas the IOUT_OC_FAULT bit is not set unless the time limit set by the capacitor on the TIMER pin elapses. |
| [2:1] | HS_SHUTDOWN_CAUSE | Latched  | 00       | The <a href="#">ADM1276</a> is either enabled and working correctly, or has been shut down using the OPERATION command.                                                                                                                                                        |
|       |                   |          | 01       | An IOUT_OC_FAULT condition occurred that caused the <a href="#">ADM1276</a> to shut down.                                                                                                                                                                                      |
|       |                   |          | 10       | A VIN_UV_FAULT condition occurred that caused the <a href="#">ADM1276</a> to shut down.                                                                                                                                                                                        |
|       |                   |          | 11       | A VIN_OV_FAULT condition occurred that caused the <a href="#">ADM1276</a> to shut down.                                                                                                                                                                                        |
| [0]   | IOUT_WARN2        | Latched  | 0        | No overcurrent condition on the output supply detected by the power monitor using the IOUT_WARN2_LIMIT command.                                                                                                                                                                |
|       |                   |          | 1        | An undercurrent or overcurrent condition on the output supply was detected by the power monitor using the IOUT_WARN2_LIMIT command. The polarity of the threshold condition is set by the IOUT_WARN2_SELECT bit using the DEVICE_CONFIG command.                               |

**READ\_EIN**

Code: 0x86, block read. Value after reset: 0x06, 0x0000, 0x00, 0x000000.

**Table 25. Byte Descriptions for READ\_EIN Command**

| Byte  | Byte Name      | Value    | Description                                                                                                                                                                                                                                                                                  |
|-------|----------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [0]   | Byte count     | 0x06     | Always reads as 0x06, the number of data bytes that the block read command should expect to read.                                                                                                                                                                                            |
| [2:1] | Energy count   | 0x0000   | Energy accumulator value in direct format. Byte 2 is the high byte, and Byte 1 is the low byte. Internally, the energy accumulator is a 24-bit value, but only the most significant 16 bits are returned with this command. Use the READ_EIN_EXT command to access the nontruncated version. |
| [3]   | Rollover count | 0x00     | Number of times that the energy count has rolled over from 0x7FFF to 0x0000. This is a straight 8-bit binary value.                                                                                                                                                                          |
| [6:4] | Sample count   | 0x000000 | This is the total number of PIN samples acquired and accumulated in the energy count accumulator. Byte 6 is the high byte, Byte 5 is the middle byte, and Byte 4 is the low byte. This is a straight 24-bit binary value.                                                                    |

**READ\_VIN**

Code: 0x88, read word. Value after reset: 0x0000.

**Table 26. Bit Descriptions for READ\_VIN Command**

| Bits    | Bit Name | Settings | Description                                                            |
|---------|----------|----------|------------------------------------------------------------------------|
| [15:12] | Reserved | 0000     | Always reads as 0000.                                                  |
| [11:0]  | VIN      |          | Input voltage from the SENSE+ pin measurement, expressed in ADC codes. |

**READ\_VOUT**

Code: 0x8B, read word. Value after reset: 0x0000.

**Table 27. Bit Descriptions for READ\_VOUT Command**

| Bits    | Bit Name | Settings | Description                                                           |
|---------|----------|----------|-----------------------------------------------------------------------|
| [15:12] | Reserved | 0000     | Always reads as 0000.                                                 |
| [11:0]  | VOUT     |          | Output voltage from the VOUT pin measurement, expressed in ADC codes. |

**READ\_IOUT**

Code: 0x8C, read word. Value after reset: 0x0000.

**Table 28. Bit Descriptions for READ\_IOUT Command**

| Bits    | Bit Name | Settings | Description                                                                             |
|---------|----------|----------|-----------------------------------------------------------------------------------------|
| [15:12] | Reserved | 0000     | Always reads as 0000.                                                                   |
| [11:0]  | IOUT     |          | Output current from the measurement through the sense resistor, expressed in ADC codes. |

**READ\_PIN**

Code: 0x97, read word. Value after reset: 0x0000.

**Table 29. Bit Descriptions for READ\_PIN Command**

| Bits   | Bit Name | Settings | Description                                  |
|--------|----------|----------|----------------------------------------------|
| [15]   | Reserved | 0        | Always reads as 0.                           |
| [14:0] | PIN      |          | Input power from the VIN × IOUT calculation. |

**PMBUS\_REVISION**

Code: 0x98, read byte. Value after reset: 0x22.

**Table 30. Bit Descriptions for PMBUS\_REVISION Command**

| Bits  | Bit Name         | Settings | Description                                                      |
|-------|------------------|----------|------------------------------------------------------------------|
| [7:4] | Part I revision  | 0010     | Always reads as 0010, PMBus Specification Part I, Revision 1.2.  |
| [3:0] | Part II revision | 0010     | Always reads as 0010, PMBus Specification Part II, Revision 1.2. |

**MFR\_ID**

Code: 0x99, block read. Value after reset: 0x03 + ASCII “ADI.”

**Table 31. Byte Descriptions for MFR\_ID Command**

| Byte | Byte Name   | Value       | Description                                                                                 |
|------|-------------|-------------|---------------------------------------------------------------------------------------------|
| [0]  | Byte count  | 0x03        | Always reads as 0x03, the number of data bytes that the block read command expects to read. |
| [1]  | Character 1 | 0x41 or “A” | Always reads as 0x41.                                                                       |
| [2]  | Character 2 | 0x44 or “D” | Always reads as 0x44.                                                                       |
| [3]  | Character 3 | 0x49 or “I” | Always reads as 0x49.                                                                       |

**MFR\_MODEL**

Code: 0x9A, block read. Value after reset: 0x09 + ASCII “ADM1276-3.”

**Table 32. Byte Descriptions for MFR\_MODEL Command**

| Byte | Byte Name   | Value       | Description                                                                                 |
|------|-------------|-------------|---------------------------------------------------------------------------------------------|
| [0]  | Byte count  | 0x09        | Always reads as 0x09, the number of data bytes that the block read command expects to read. |
| [1]  | Character 1 | 0x41 or “A” | Always reads as 0x41.                                                                       |
| [2]  | Character 2 | 0x44 or “D” | Always reads as 0x44.                                                                       |
| [3]  | Character 3 | 0x4D or “M” | Always reads as 0x4D.                                                                       |
| [4]  | Character 4 | 0x31 or “1” | Always reads as 0x31.                                                                       |
| [5]  | Character 5 | 0x32 or “2” | Always reads as 0x32.                                                                       |
| [6]  | Character 6 | 0x37 or “7” | Always reads as 0x37.                                                                       |
| [7]  | Character 7 | 0x36 or “6” | Always reads as 0x36.                                                                       |
| [8]  | Character 8 | 0x2D or “-” | Always reads as 0x2D.                                                                       |
| [9]  | Character 9 | 0x33 or “3” | Always reads as 0x33.                                                                       |

**MFR\_REVISION**

Code: 0x9B, block read. Value after reset: 0x01 + ASCII “0.”

**Table 33. Byte Descriptions for MFR\_REVISION Command**

| Byte | Byte Name   | Value       | Description                                                                                 |
|------|-------------|-------------|---------------------------------------------------------------------------------------------|
| [0]  | Byte count  | 0x01        | Always reads as 0x01, the number of data bytes that the block read command expects to read. |
| [1]  | Character 1 | 0x30 or “0” | Always reads as 0x30, Revision 0 of the <a href="#">ADM1276</a> .                           |

**PEAK\_IOUT**

Code: 0xD0, read/write word. Value after reset: 0x0000 (writing 0x0000 clears the peak value).

**Table 34. Bit Descriptions for PEAK\_IOUT Command**

| Bits    | Bit Name  | Settings | Description                                                        |
|---------|-----------|----------|--------------------------------------------------------------------|
| [15:12] | Reserved  | 0000     | Always reads as 0000.                                              |
| [11:0]  | PEAK_IOUT |          | Returns the peak IOUT current since the register was last cleared. |

**PEAK\_VIN**

Code: 0xD1, read/write word. Value after reset: 0x0000 (writing 0x0000 clears the peak value).

**Table 35. Bit Descriptions for PEAK\_VIN Command**

| Bits    | Bit Name | Settings | Description                                                       |
|---------|----------|----------|-------------------------------------------------------------------|
| [15:12] | Reserved | 0000     | Always reads as 0000.                                             |
| [11:0]  | PEAK_VIN |          | Returns the peak VIN voltage since the register was last cleared. |

**PEAK\_VOUT**

Code: 0xD2, read/write word. Value after reset: 0x0000 (writing 0x0000 clears the peak value).

**Table 36. Bit Descriptions for PEAK\_VOUT Command**

| Bits    | Bit Name  | Settings | Description                                                        |
|---------|-----------|----------|--------------------------------------------------------------------|
| [15:12] | Reserved  | 0000     | Always reads as 0000.                                              |
| [11:0]  | PEAK_VOUT |          | Returns the peak VOUT voltage since the register was last cleared. |

**PMON\_CONTROL**

Code: 0xD3, read/write byte. Value after reset: 0x01.

**Table 37. Bit Descriptions for PMON\_CONTROL Command**

| Bits  | Bit Name | Settings | Description                                                                                                                                                                                                                                           |
|-------|----------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7:1] | Reserved | 0000000  | Always reads as 0000000.                                                                                                                                                                                                                              |
| [0]   | Convert  | 0<br>1   | Power monitor is not running.<br>Default. Start the sampling of current and voltage with the power monitor. In single shot mode, this bit clears itself after one complete cycle. In continuous mode, this bit must be written to 0 to stop sampling. |

**PMON\_CONFIG**

Code: 0xD4, read/write byte. Value after reset: 0xAF.

Modifying the power monitor settings while the power monitor is sampling is not supported. The power monitor must be stopped before any setting in Table 38 is changed to ensure correct operation and to prevent the generation of any potential spurious data and status alerts.

**Table 38. Bit Descriptions for PMON\_CONFIG Command**

| Bits  | Bit Name    | Settings                                             | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-------|-------------|------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7]   | PMON_MODE   | 0<br>1                                               | This setting selects single shot sampling mode.<br>Default. This setting selects continuous sampling mode.                                                                                                                                                                                                                                                                                                                                                                                                                         |
| [6]   | VOUT_SELECT | 0<br>1                                               | Default. The power monitor samples the input voltage on the SENSE+ pin and IOUT.<br>The power monitor samples the input voltage on the SENSE+ pin, IOUT, and the voltage on the VOUT pin.                                                                                                                                                                                                                                                                                                                                          |
| [5]   | VRANGE      | 0<br>1                                               | Sets the voltage input range from 0 V to 6 V (low input voltage range).<br>Default. Sets the voltage input range from 0 V to 20 V (high input voltage range).                                                                                                                                                                                                                                                                                                                                                                      |
| [4]   | Reserved    | 0                                                    | Reserved. This bit must always be written as 0.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| [3]   | Reserved    | 1                                                    | Default. This bit must be set to 1 for the power monitor current sense to operate correctly.                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| [2:0] | Averaging   | 000<br>001<br>010<br>011<br>100<br>101<br>110<br>111 | Disables sample averaging for current and voltage.<br>Sets sample averaging for current and voltage to two samples.<br>Sets sample averaging for current and voltage to four samples.<br>Sets sample averaging for current and voltage to eight samples.<br>Sets sample averaging for current and voltage to 16 samples.<br>Sets sample averaging for current and voltage to 32 samples.<br>Sets sample averaging for current and voltage to 64 samples.<br>Default. Sets sample averaging for current and voltage to 128 samples. |

**ALERT2\_CONFIG**

Code: 0xD6, read/write word. Value after reset: 0x8000.

**Table 39. Bit Descriptions for ALERT2\_CONFIG Command**

| Bits  | Bit Name           | Settings             | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|-------|--------------------|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [15]  | FET_HEALTH_BAD_EN2 | 0<br>1               | Disables generation of an SMBAlert when the FET_HEALTH_BAD bit is set.<br>Default. Generates SMBAlert when the FET_HEALTH_BAD bit is set. This bit is active from power-up for a FET problem to be detected and flagged immediately without the need for software to set this bit.                                                                                                                                                                                                                                                                                                                                                    |
| [14]  | IOUT_OC_FAULT_EN2  | 0<br>1               | Default. Disables generation of an SMBAlert when the IOUT_OC_FAULT bit is set.<br>Generates an SMBAlert when the IOUT_OC_FAULT bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| [13]  | VIN_OV_FAULT_EN2   | 0<br>1               | Default. Disables generation of an SMBAlert when the VIN_OV_FAULT bit is set.<br>Generates an SMBAlert when the VIN_OV_FAULT bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| [12]  | VIN_UV_FAULT_EN2   | 0<br>1               | Default. Disables generation of an SMBAlert when the VIN_UV_FAULT bit is set.<br>Generates an SMBAlert when the VIN_UV_FAULT bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| [11]  | CML_ERROR_EN2      | 0<br>1               | Default. Disables generation of an SMBAlert when the CML_ERROR bit is set.<br>Generates an SMBAlert when the CML_ERROR bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| [10]  | IOUT_OC_WARN_EN2   | 0<br>1               | Default. Disables generation of an SMBAlert when the IOUT_OC_WARN bit is set.<br>Generates an SMBAlert when the IOUT_OC_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| [9]   | IOUT_WARN2_EN2     | 0<br>1               | Default. Disables generation of an SMBAlert when the IOUT_WARN2 bit is set.<br>Generates an SMBAlert when the IOUT_WARN2 bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| [8]   | VIN_OV_WARN_EN2    | 0<br>1               | Default. Disables generation of an SMBAlert when the VIN_OV_WARN bit is set.<br>Generates an SMBAlert when the VIN_OV_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| [7]   | VIN_UV_WARN_EN2    | 0<br>1               | Default. Disables generation of an SMBAlert when the VIN_UV_WARN bit is set.<br>Generates an SMBAlert when the VIN_UV_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| [6]   | VOUT_OV_WARN_EN2   | 0<br>1               | Default. Disables generation of an SMBAlert when the VOUT_OV_WARN bit is set.<br>Generates an SMBAlert when the VOUT_OV_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| [5]   | VOUT_UV_WARN_EN2   | 0<br>1               | Default. Disables generation of an SMBAlert when the VOUT_UV_WARN bit is set.<br>Generates an SMBAlert when the VOUT_UV_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| [4]   | HS_INLIM_EN2       | 0<br>1               | Default. Disables generation of an SMBAlert when the HS_INLIM bit is set.<br>Generates an SMBAlert when the HS_INLIM bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| [3]   | PIN_OP_WARN_EN2    | 0<br>1               | Default. Disables generation of an SMBAlert when the PIN_OP_WARN bit is set.<br>Generates an SMBAlert when the PIN_OP_WARN bit is set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| [2:1] | GPO2_MODE          | 00<br>01<br>10<br>11 | Default. GPO2 is configured to generate SMBAlerts.<br>GPO2 can be used as a general-purpose digital output pin. The GPO2_INVERT bit is used to change the output state.<br>Reserved.<br>GPO2 is configured for digital comparator mode. The output pin continuously shows for the selected warning(s) if the relevant warning threshold has been exceeded. In effect, this is an unlatched SMBAlert. If multiple bits are selected, the output values are OR'ed together. Only warning threshold comparisons affect the pin in this mode. If other bits such as VIN_UV_FAULT_EN2 are set, they are ignored in this mode of operation. |
| [0]   | GPO2_INVERT        | 0<br>1               | Default. The GPO2 pin is active low.<br>GPO2 is active high.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

**DEVICE\_CONFIG**

Code: 0xD8, read/write byte. Value after reset: 0x00.

**Table 40. Bit Descriptions for DEVICE\_CONFIG Command**

| Bits  | Bit Name          | Settings | Description                                                                                                                                                                                                           |
|-------|-------------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [7]   | OC_GLITCH_TIME    | 0        | Default. The long duration glitch filter is used when a severe overcurrent fault is detected.                                                                                                                         |
|       |                   | 1        | The short duration glitch filter is used when a severe overcurrent fault is detected.                                                                                                                                 |
| [6]   | FLB_DISABLE       | 0        | Default. Foldback is enabled and can affect the hot swap current sense limit.                                                                                                                                         |
|       |                   | 1        | Foldback is disabled and does not affect the hot swap current sense limit. This setting can be useful if the sole purpose of the FLB pin is to act as a power-good input.                                             |
| [5]   | OPERATION_CMD_EN  | 0        | Default. The OPERATION command is disabled, and the <a href="#">ADM1276</a> issues a no acknowledge if the command is received. This setting provides some protection against a card accidentally turning itself off. |
|       |                   | 1        | The OPERATION command is enabled, and the <a href="#">ADM1276</a> responds to it.                                                                                                                                     |
| [4]   | IOUT_WARN2_SELECT | 0        | Default. Configures IOUT_WARN2_LIMIT as an undercurrent threshold.                                                                                                                                                    |
|       |                   | 1        | Configures IOUT_WARN2_LIMIT as an overcurrent threshold.                                                                                                                                                              |
| [3:0] | Reserved          | 0000     | Always reads as 0000.                                                                                                                                                                                                 |

**POWER\_CYCLE**

Code: 0xD9, send byte, no data.

**PEAK\_PIN**

Code: 0xDA, read/write word. Value after reset: 0x0000 (writing 0x0000 clears the peak value).

**Table 41. Bit Descriptions for PEAK\_PIN Command**

| Bits   | Bit Name | Settings | Description                                                       |
|--------|----------|----------|-------------------------------------------------------------------|
| [15]   | Reserved | 0        | Always reads as 0.                                                |
| [14:0] | PEAK_PIN |          | Returns the peak input power since the register was last cleared. |

**READ\_PIN\_EXT**

Code: 0xDB, block read. Value after reset: 0x03, 0x000000.

**Table 42. Byte Descriptions for READ\_PIN\_EXT Command**

| Byte  | Byte Name    | Value    | Description                                                                                                                                       |
|-------|--------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| [0]   | Byte count   | 0x03     | Always reads as 0x03, the number of data bytes that the block read command expects to read.                                                       |
| [3:1] | PIN extended | 0x000000 | Result of the VIN × IOUT calculation that has not been truncated. Byte 3 is the high byte, Byte 2 is the middle byte, and Byte 1 is the low byte. |

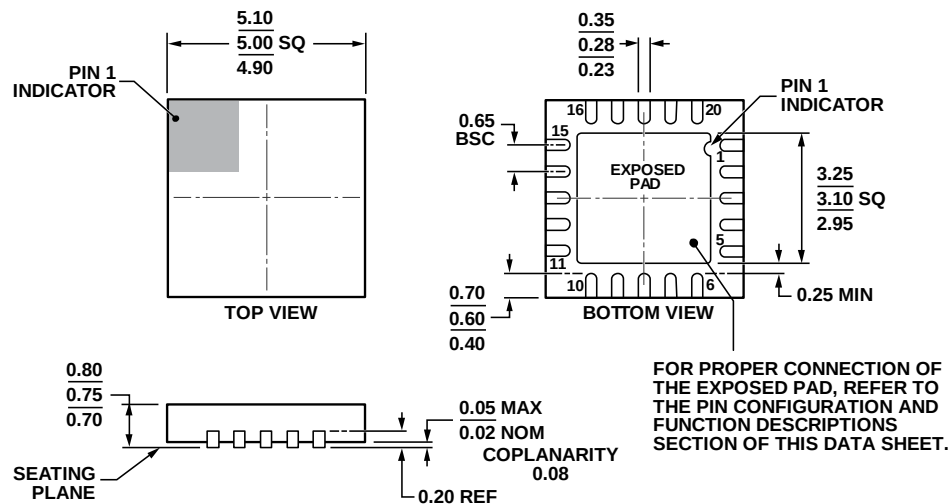
**READ\_EIN\_EXT**

Code: 0xDC, block read. Value after reset: 0x08, 0x000000, 0x0000, 0x000000.

**Table 43. Byte Descriptions for READ\_EIN\_EXT Command**

| Byte  | Byte Name               | Value    | Description                                                                                                                                                                 |
|-------|-------------------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| [0]   | Byte count              | 0x08     | Always reads as 0x08, the number of data bytes that the block read command expects to read.                                                                                 |
| [3:1] | Energy count extended   | 0x000000 | 24-bit energy accumulator in direct format. Byte 3 is the high byte, Byte 2 is the middle byte, and Byte 1 is the low byte.                                                 |
| [5:4] | Rollover count extended | 0x0000   | Number of times that the energy counter has rolled over from 0x7FFF to 0x0000. This is a straight 16-bit binary value. Byte 5 is the high byte, and Byte 4 is the low byte. |
| [8:6] | Sample count            | 0x000000 | Total number of PIN samples acquired and accumulated in the energy count accumulator. Byte 8 is the high byte, Byte 7 is the middle byte, and Byte 6 is the low byte.       |

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WHHC.

Figure 61. 20-Lead Lead Frame Chip Scale Package [LFCSP\_WQ]  
 5 mm × 5 mm Body, Very Very Thin Quad  
 (CP-20-9)  
 Dimensions shown in millimeters

111908-A

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description | Package Option |
|--------------------|-------------------|---------------------|----------------|
| ADM1276-3ACPZ      | −40°C to +85°C    | 20-Lead LFCSP_WQ    | CP-20-9        |
| ADM1276-3ACPZ-RL   | −40°C to +85°C    | 20-Lead LFCSP_WQ    | CP-20-9        |
| EVAL-ADM1276EBZ    |                   | Evaluation Kit      |                |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

NOTES

## NOTES

I<sup>2</sup>C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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